

SLES075B − MARCH 2003 − REVISED NOVEMBER 2006

24-BIT, 192-kHz SAMPLING, ADVANCED SEGMENT, AUDIO STEREO DIGITAL-TO-ANALOG CONVERTER

FEATURES

- **Supports Both DSD and PCM Formats**
- **24-Bit Resolution**
- **Analog Performance:**
  - **Dynamic Range: 113 dB**
  - **THD+N: 0.001%**
  - **Full-Scale Output: 2.1 V rms (at Postamplifier)**
- **Differential Voltage Output: 3.2 V p-p**
- **8× Oversampling Digital Filter:**
  - **Stop-Band Attenuation: –82 dB**
  - **Pass-Band Ripple: ±0.002 dB**
- **Sampling Frequency: 10 kHz to 200 kHz**
- **System Clock: 128, 192, 256, 384, 512, or 768 f_S With Autodetect**
- **Accepts 16-, 20-, and 24-Bit Audio Data**
- **PCM Data Formats: Standard, I^2S, and Left-Justified**
- **DSD Format Interface Available**
- **Optional Interface to External Digital Filter or DSP Available**
- **I^2C-Compatible Serial Port**
- **User-Programmable Mode Controls:**
  - **Digital Attenuation: 0 dB to –120 dB, 0.5 dB/Step**
  - **Digital De-Emphasis**
  - **Digital Filter Rolloff: Sharp or Slow**
  - **Soft Mute**
  - **Zero Flags for Each Output in PCM and DSD Formats**
- **Dual Supply Operation:**
  - **5-V Analog, 3.3-V Digital**
- **5-V Tolerant Digital Inputs**
- **Small 28-Lead SSOP Package**

APPLICATIONS

- **A/V Receivers**
- **SACD Players**
- **DVD Players**
- **HDTV Receivers**
- **Car Audio Systems**
- **Digital Multitrack Recorders**
- **Other Applications Requiring 24-Bit Audio**

DESCRIPTION

The DSD1793 is a monolithic CMOS integrated circuit that includes stereo digital-to-analog converters and support circuitry in a small 28-lead SSOP package. The data converters use TI's advanced-segment DAC architecture to achieve excellent dynamic performance and improved tolerance to clock jitter. The DSD1793 provides balanced voltage outputs, allowing the user to optimize analog performance externally. The DSD1793 accepts the PCM and DSD audio data formats, providing easy interfacing to audio DSP and decoder chips. The DSD1793 also accepts interfaces to external digital filter devices (DF1704, DF1706, PMD200). Sampling rates up to 200 kHz are supported. A full set of user-programmable functions is accessible through an I^2C-compatible serial control port.



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

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ORDERING INFORMATION

PRODUCT	PACKAGE	PACKAGE CODE	OPERATION TEMPERATURE RANGE	PACKAGE MARKING	ORDERING NUMBER	TRANSPORT MEDIA
DSD1793DB	28-lead SSOP	28DB	–25°C to 85°C	DSD1793	DSD1793DB	Tube
					DSD1793DBR	Tape and reel

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range unless otherwise noted(1)

		DSD1791
Supply voltage	$V_{CC}F$, $V_{CC}L$, $V_{CC}C$, $V_{CC}R$	–0.3 V to 6.5 V
	V_{DD}	–0.3 V to 4 V
Supply voltage differences: $V_{CC}F$, $V_{CC}L$, $V_{CC}C$, $V_{CC}R$		±0.1 V
Ground voltage differences: AGNDF, AGNDL, AGNDC, AGNDR, DGND		±0.1 V
Digital input voltage	PLRCK, PDATA, PBCK, DSDL, DSDR, DBCK, ADR0, ADR1, SCK, SCL, SDA	–0.3 V to 6.5 V
	ZEROL, ZEROR	–0.3 V to (V_{DD} + 0.3 V) < 4 V
Analog input voltage		–0.3 V to (V_{CC} + 0.3 V) < 6.5 V
Input current (any pins except supplies)		±10 mA
Ambient temperature under bias		–40°C to 125°C
Storage temperature		–55°C to 150°C
Junction temperature		150°C
Lead temperature (soldering)		260°C, 5 s
Package temperature (IR reflow, peak)		260°C

(1) Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

all specifications at T_A = 25°C, V_{CC} = 5 V, V_{DD} = 3.3 V, f_S = 44.1 kHz, system clock = 256 f_S, and 24-bit data, unless otherwise noted

PARAMETER		DSD1793DB			UNIT
		MIN	TYP	MAX	
RESOLUTION			24		Bits
DATA FORMAT (PCM Mode)					
	Audio data interface format		Standard, I^2S, left justified		
	Audio data bit length		16-, 20-, 24-bit selectable		
	Audio data format		MSB first, 2s complement		
f_S	Sampling frequency	10		200	kHz
	System clock frequency		128, 192, 256, 384, 512, 768 f_S		
DATA FORMAT (DSD Mode)					
	Audio data interface format		DSD (direct stream digital)		
	Audio data bit length		1 Bit		
f_S	Sampling frequency		2.8224		MHz
	System clock frequency	2.8224		11.2896	MHz

ELECTRICAL CHARACTERISTICS (Continued)

all specifications at T_A = 25°C, V_{CC} = 5 V, V_{DD} = 3.3 V, f_S = 44.1 kHz, system clock = 256 f_S, and 24-bit data, unless otherwise noted

PARAMETER		TEST CONDITIONS	DSD1793DB			UNIT
			MIN	TYP	MAX	
DIGITAL INPUT/OUTPUT						
	Logic family			TTL compatible		
V_{IH}	Input logic level		2			VDC
V_{IL}					0.8	
I_{IH}	Input logic current	$V_{IN} = V_{DD}$			10	µA
I_{IL}		V_{IN} = 0 V			–10	
V_{OH}	Output logic level	I_{OH} = –2 mA	2.4			VDC
V_{OL}		I_{OL} = 2 mA			0.4	
DYNAMIC PERFORMANCE (PCM MODE) (1)						
	THD+N at V_{OUT} = 0 dB	f_S = 44.1 kHz		0.001%	0.002%	
		f_S = 96 kHz		0.0015%		
		f_S = 192 kHz		0.003%		
	Dynamic range	EIAJ, A-weighted, f_S = 44.1 kHz	110	113		dB
		EIAJ, A-weighted, f_S = 96 kHz		113		
		EIAJ, A-weighted, f_S = 192 kHz		113		
	Signal-to-noise ratio	EIAJ, A-weighted, f_S = 44.1 kHz	110	113		dB
		EIAJ, A-weighted, f_S = 96 kHz		113		
		EIAJ, A-weighted, f_S = 192 kHz		113		
	Channel separation	f_S = 44.1 kHz	106	110		dB
		f_S = 96 kHz		110		
		f_S = 192 kHz		109		
	Level linearity error	V_{OUT} = –120 dB		±1		dB
DYNAMIC PERFORMANCE (DSD MODE) (1) (2)						
	THD+N at V_{OUT} = 0 dB	2.1 V rms		0.001%		
	Dynamic range	–60 dB, EIAJ, A-weighted		113		dB
	Signal-to-noise ratio	EIAJ, A-weighted		113		dB
ANALOG OUTPUT						
	Gain error		–8	±3	8	% of FSR
	Gain mismatch, channel-to-channel		–3	±0.5	3	% of FSR
	Bipolar zero error	At BPZ	–2	±0.5	2	% of FSR
	Differential output voltage (3)	Full scale (0 dB)		3.2		V p-p
	Bipolar zero voltage (3)	At BPZ		1.4		V
	Load impedance (3)	$R_1 = R_2$	1.7			kΩ

(1) Dynamic performance and dc accuracy are specified at the output of the postamplifier as shown in Figure 32. Analog performance specifications are measured using the System Two™ Cascade audio measurement system by Audio Precision™ in the averaging mode. For all sampling-frequency operations, measurement bandwidth is limited with a 20-kHz AES17 filter.

(2) Analog performance in the DSD mode is specified as the DSD modulation index of 100%. This is equilvalent to PCM mode performance at 44.1 kHz and 64 f_S.

(3) These parameters are defined at the DSD1793 output pins. Load impedances, R_1 and R_2, are input resistors of the postamplifier. They are defined as dc-coupled loads.

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Other trademarks are the property of their respective owners.

ELECTRICAL CHARACTERISTICS (Continued)

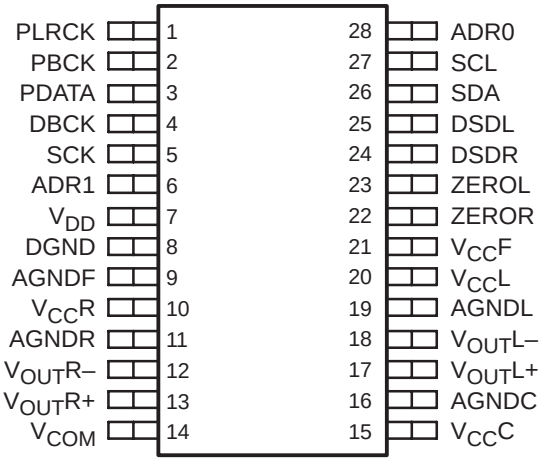
all specifications at T_A = 25°C, V_{CC} = 5 V, V_{DD} = 3.3 V, f_S = 44.1 kHz, system clock = 256 f_S, and 24-bit data, unless otherwise noted

PARAMETER		TEST CONDITIONS	DSD1793DB			UNIT
			MIN	TYP	MAX	
DIGITAL FILTER PERFORMANCE						
	De-emphasis error				±0.1	dB
FILTER CHARACTERISTICS-1: SHARP ROLLOFF						
	Pass band	±0.002 dB			0.454 f_S	
		–3 dB			0.49 f_S	
	Stop band		0.546 f_S			
	Pass-band ripple				±0.002	dB
	Stop-band attenuation	Stop band = 0.546 f_S	–75			dB
		Stop band = 0.567 f_S	–82			
	Delay time			29/f_S		s
FILTER CHARACTERISTICS-2: SLOW ROLLOFF						
	Pass band	±0.04 dB			0.274 f_S	
		–3 dB			0.454 f_S	
	Stop band		0.732 f_S			
	Pass-band ripple				±0.002	dB
	Stop-band attenuation	Stop band = 0.732 f_S	–82			dB
	Delay time			29/f_S		s
POWER SUPPLY REQUIREMENTS						
V_{DD}	Voltage range		3	3.3	3.6	VDC
V_{CC}			4.5	5	5.5	VDC
I_{DD}	Supply current (1)	f_S = 44.1 kHz		6.5	8	mA
		f_S = 96 kHz		13.5		
		f_S = 192 kHz		28		
I_{CC}		f_S = 44.1 kHz		14	16	mA
		f_S = 96 kHz		15		
		f_S = 192 kHz		16		
	Power dissipation (1)	f_S = 44.1 kHz		90	110	mW
		f_S = 96 kHz		120		
		f_S = 192 kHz		170		
TEMPERATURE RANGE						
	Operation temperature		–25		85	°C
θ_{JA}	Thermal resistance	28-pin SSOP		100		°C/W

(1) Input is BPZ data.

PIN ASSIGNMENTS

DSD1793
(TOP VIEW)

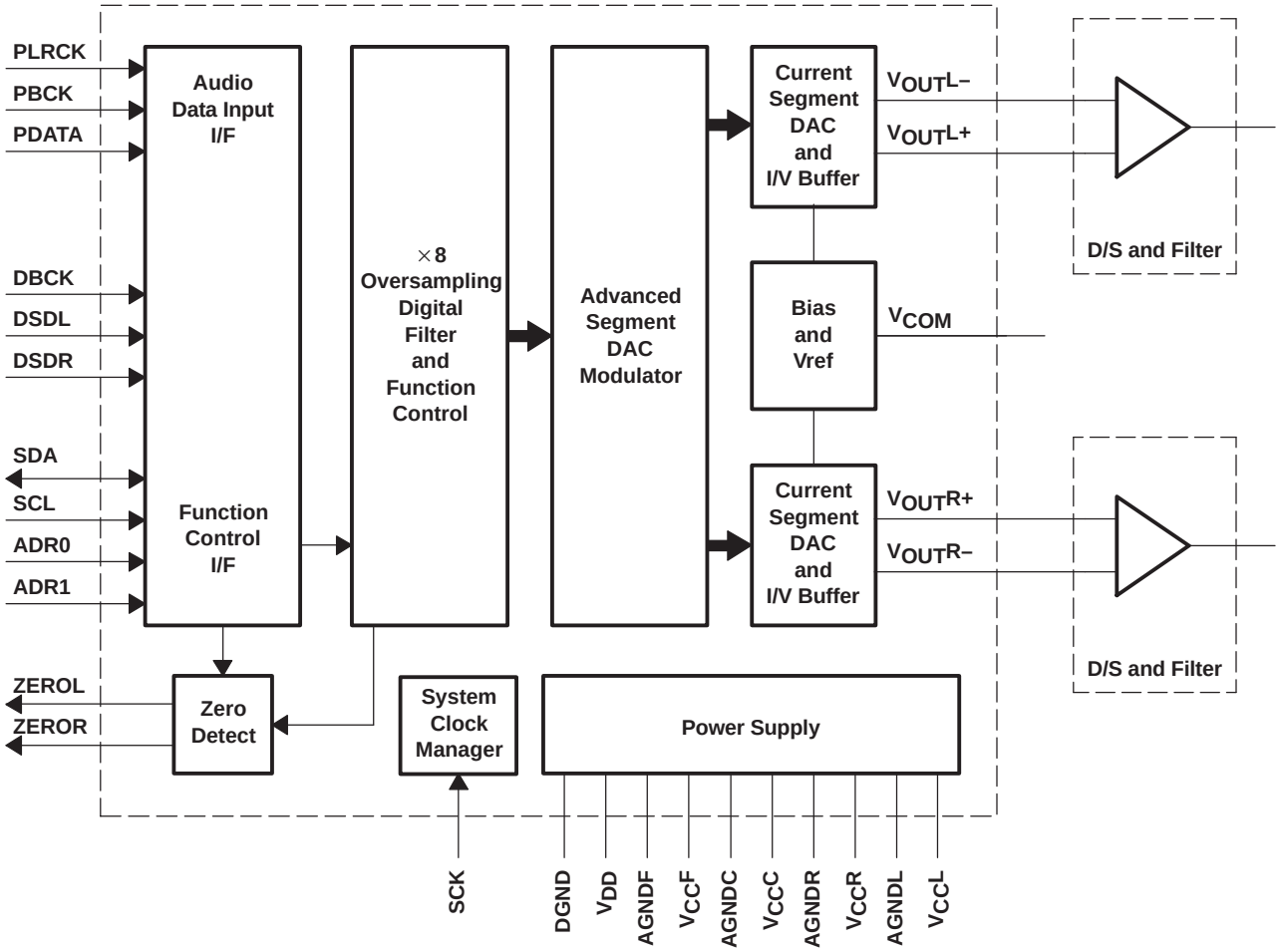


Terminal Functions

TERMINAL NAME	TERMINAL PIN	I/O	DESCRIPTIONS
ADR0	28	I	I^2C address 0 (1)
ADR1	6	I	I^2C address 1 (1)
AGNDC	16	–	Analog ground (internal bias and current DAC)
AGNDF	9	–	Analog ground (DACFF)
AGNDL	19	–	Analog ground (L-channel I/V)
AGNDR	11	–	Analog ground (R-channel I/V)
DBCK	4	I	Bit clock input for DSD mode (1)
DGND	8	–	Digital ground
DSDL	25	I	L-channel audio data input for DSD mode (1)
DSDR	24	I	R-channel audio data input for DSD mode (1)
PBCK	2	I	Bit clock input for PCM mode (1)
PDATA	3	I	Serial audio data input for PCM mode (1)
PLRCK	1	I	Left and right clock (f_S) input for PCM mode (1)
SCK	5	I	System clock input (1)
SCL	27	I	I^2C clock (1)
SDA	26	I/O	I^2C data (2)
$V_{CC}C$	15	–	Analog power supply (internal bias and current DAC), 5 V
$V_{CC}F$	21	–	Analog power supply (DACFF), 5 V
$V_{CC}L$	20	–	Analog power supply (L-channel I/V), 5 V
$V_{CC}R$	10	–	Analog power supply (R-channel I/V), 5 V
V_{COM}	14	–	Internal bias decoupling pin
V_{DD}	7	–	Digital power supply, 3.3 V
$V_{OUT}L+$	17	O	L-channel analog voltage output +
$V_{OUT}L-$	18	O	L-channel analog voltage output –
$V_{OUT}R+$	13	O	R-channel analog voltage output +
$V_{OUT}R-$	12	O	R-channel analog voltage output –
ZEROL	23	O	Zero flag for L-channel
ZEROR	22	O	Zero flag for R-channel

(1) Schmitt-trigger input, 5-V tolerant
(2) Schmitt-trigger input and output. 5-V tolerant input, and open-drain, 3-state output

FUNCTIONAL BLOCK DIAGRAM



TYPICAL PERFORMANCE CURVES

DIGITAL FILTER

Digital Filter Response

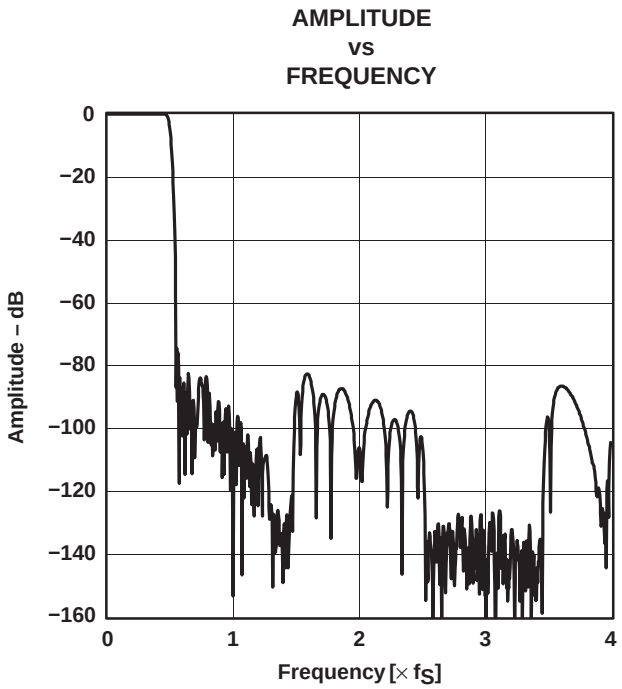


Figure 1. Frequency Response, Sharp Rolloff

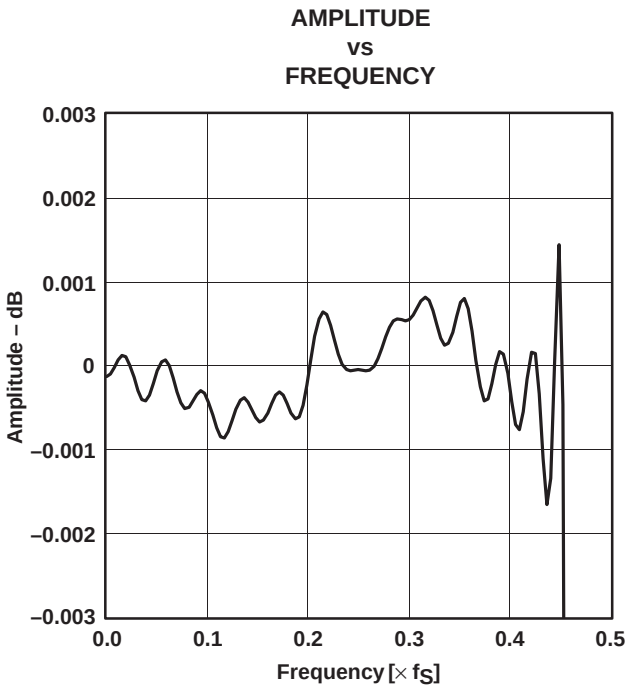


Figure 2. Pass-Band Ripple, Sharp Rolloff

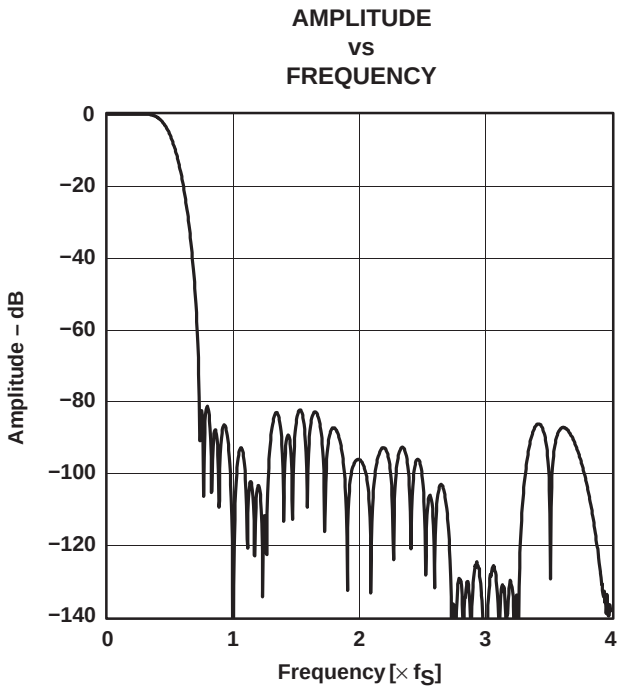


Figure 3. Frequency Response, Slow Rolloff

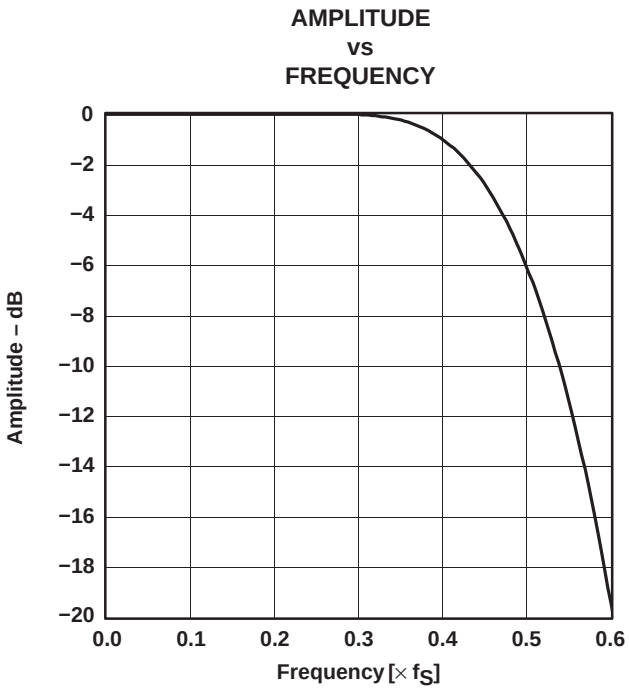


Figure 4. Transition Characteristics, Slow Rolloff

De-Emphasis Filter

DE-EMPHASIS LEVEL
vs
FREQUENCY

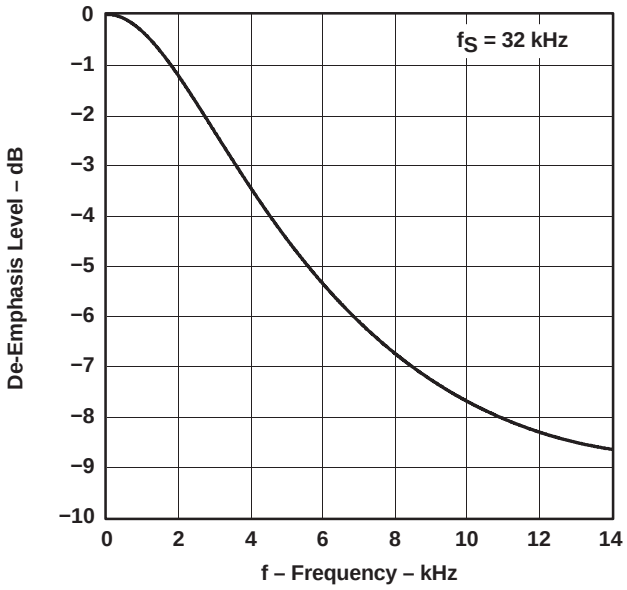


Figure 5

DE-EMPHASIS ERROR
vs
FREQUENCY

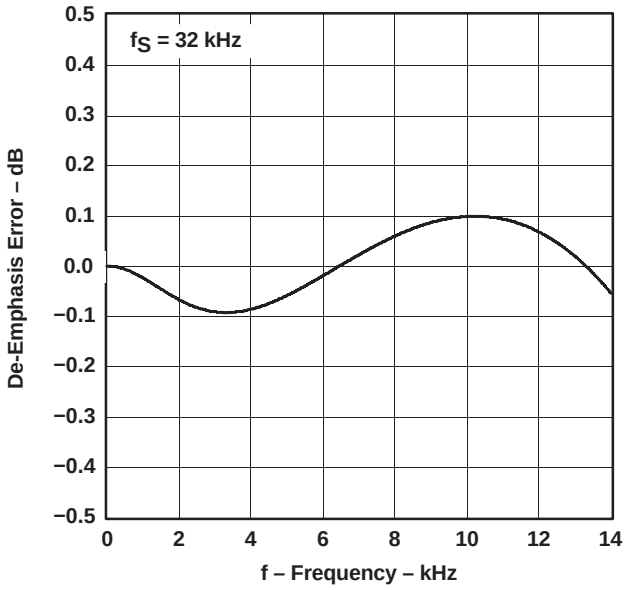


Figure 6

DE-EMPHASIS LEVEL
vs
FREQUENCY

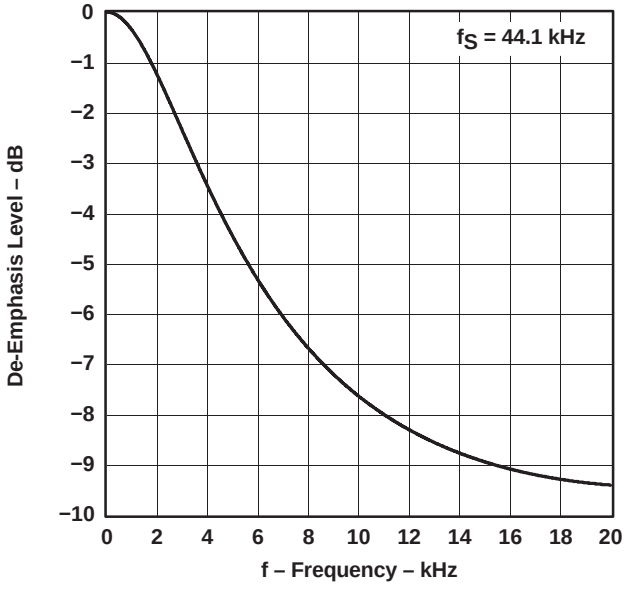


Figure 7

DE-EMPHASIS ERROR
vs
FREQUENCY

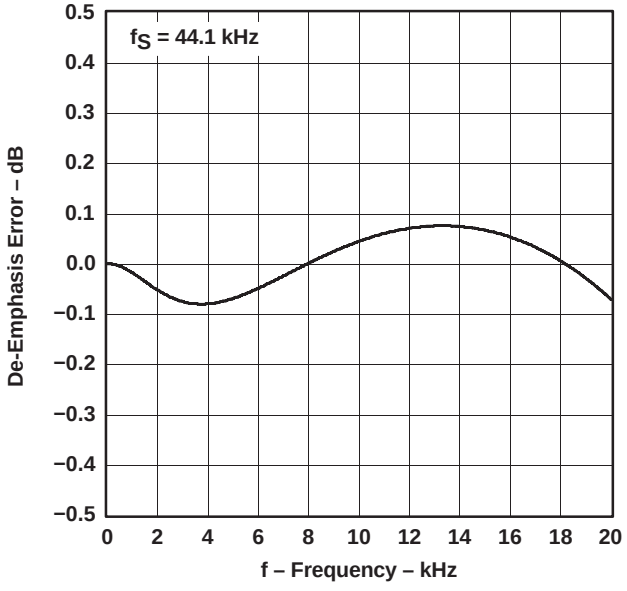


Figure 8

De-Emphasis Filter (Continued)

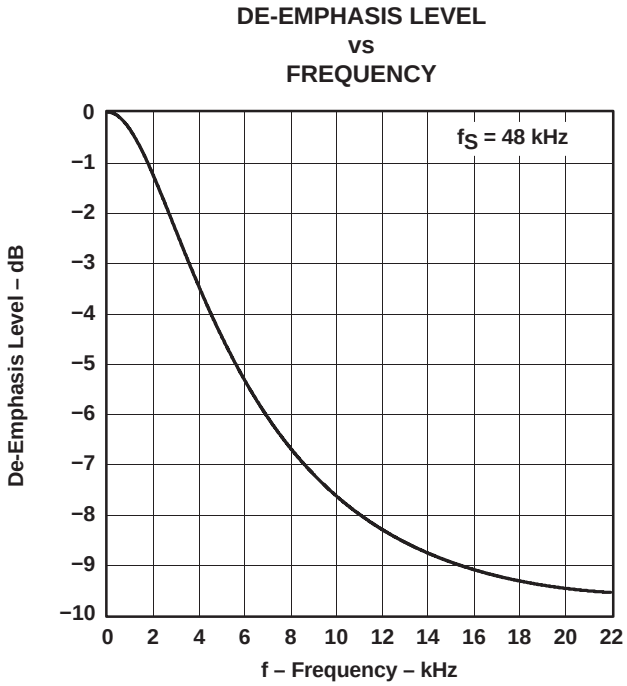


Figure 9

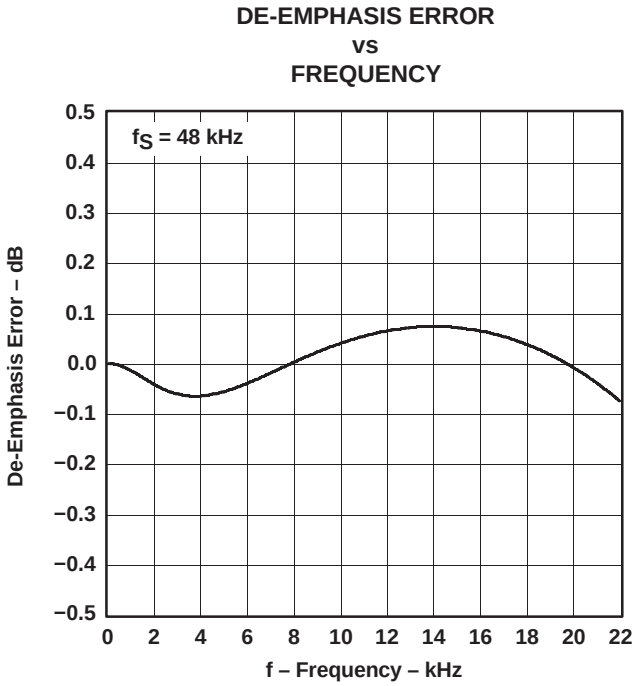


Figure 10

ANALOG DYNAMIC PERFORMANCE

Supply Voltage Characteristics

TOTAL HARMONIC DISTORTION + NOISE
vs
SUPPLY VOLTAGE

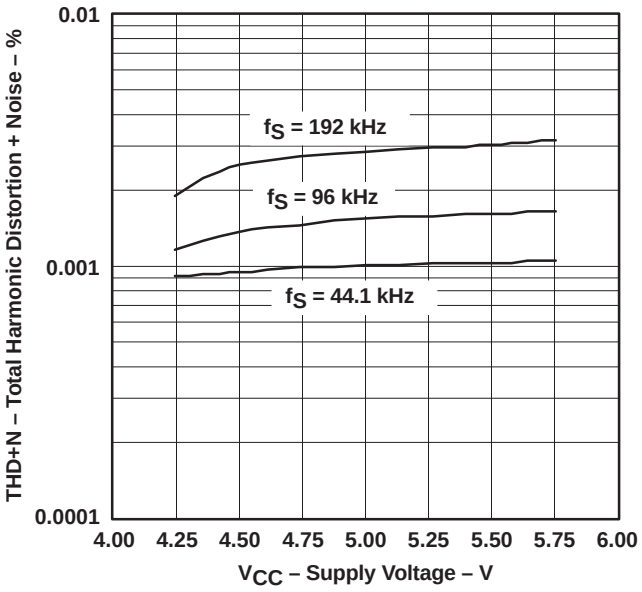


Figure 11

DYNAMIC RANGE
vs
SUPPLY VOLTAGE

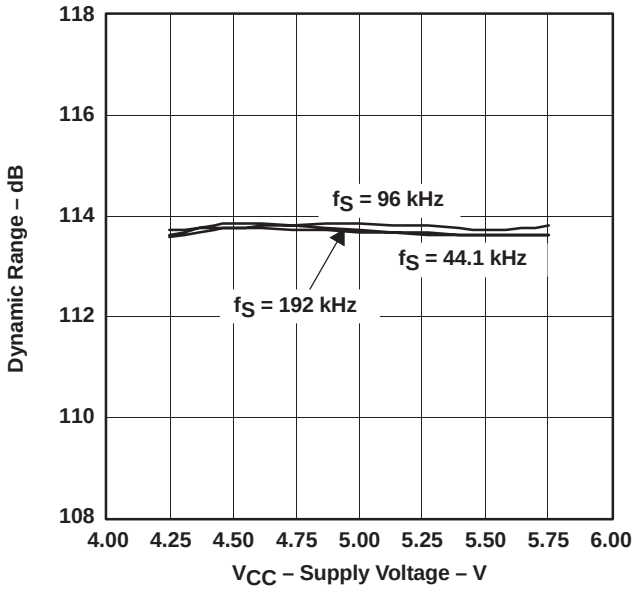


Figure 12

SIGNAL-to-NOISE RATIO
vs
SUPPLY VOLTAGE

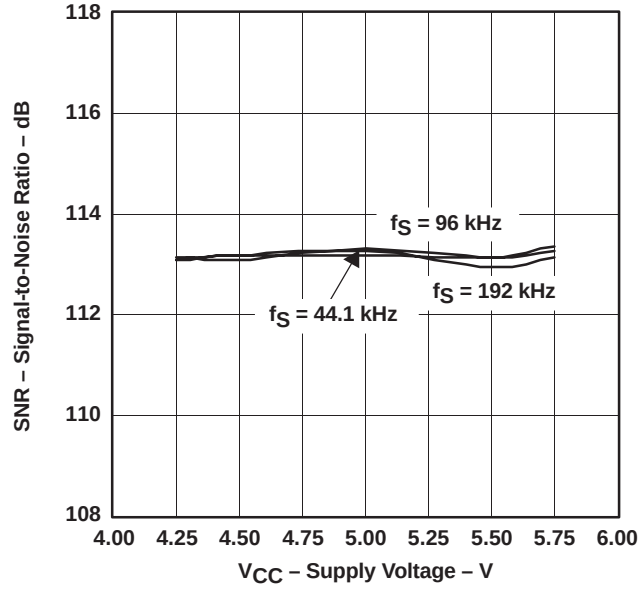


Figure 13

CHANNEL SEPARATION
vs
SUPPLY VOLTAGE

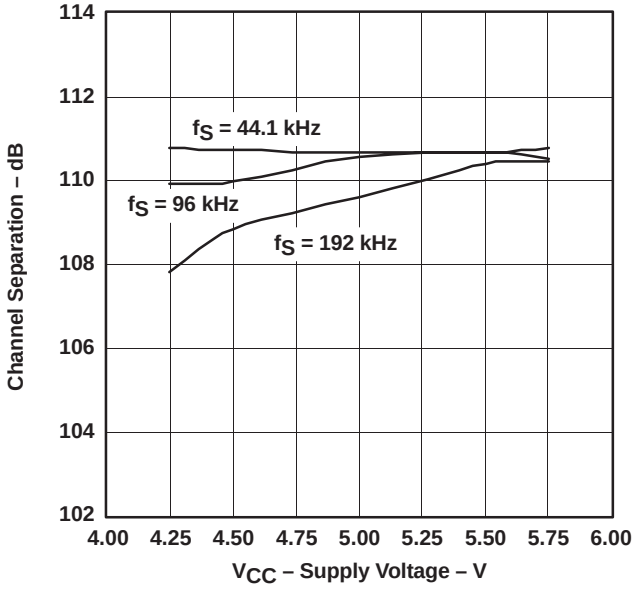


Figure 14

NOTE: PCM mode, T_A = 25°C, V_{DD} = 3.3 V.

Temperature Characteristics

TOTAL HARMONIC DISTORTION + NOISE vs FREE-AIR TEMPERATURE

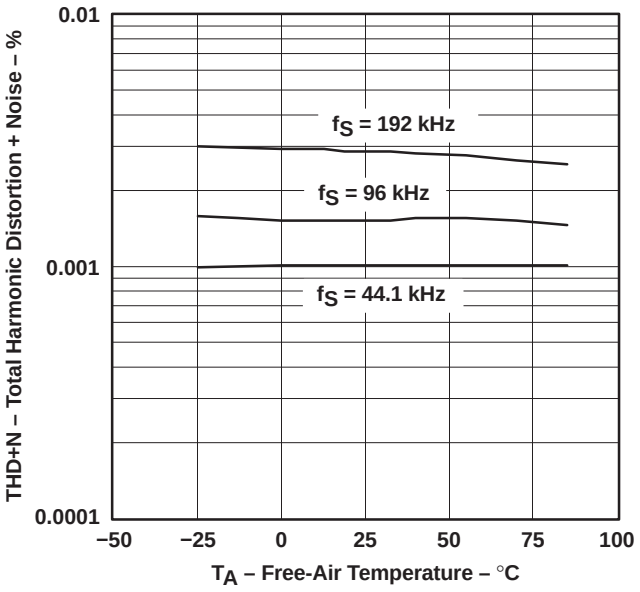


Figure 15

DYNAMIC RANGE vs FREE-AIR TEMPERATURE

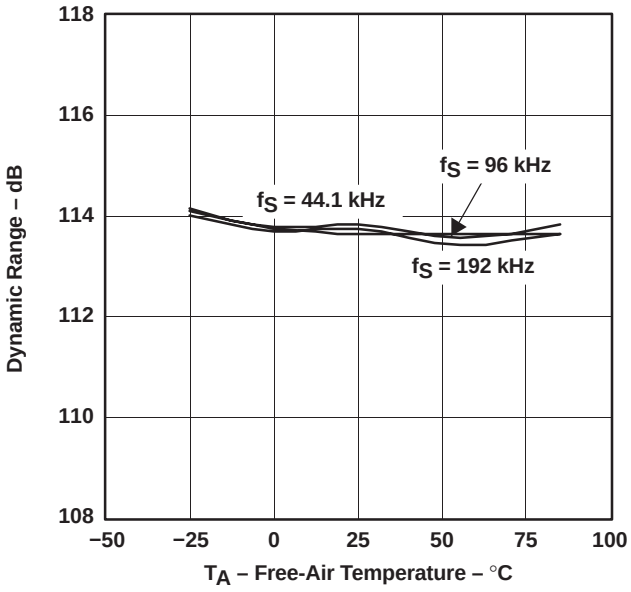


Figure 16

SIGNAL-to-NOISE RATIO vs FREE-AIR TEMPERATURE

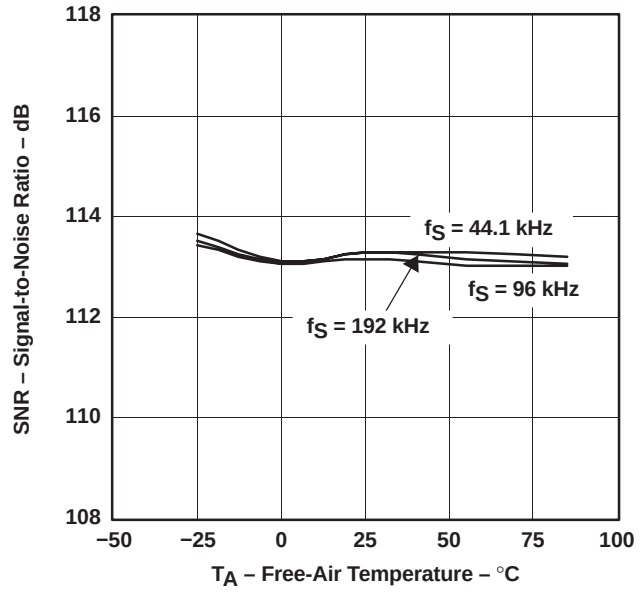


Figure 17

CHANNEL SEPARATION vs FREE-AIR TEMPERATURE

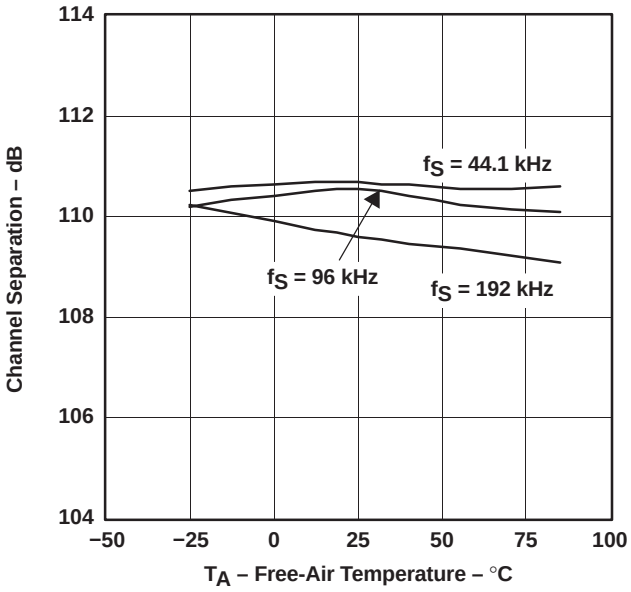


Figure 18

NOTE: PCM mode, V_{DD} = 3.3 V, V_{CC} = 5 V.

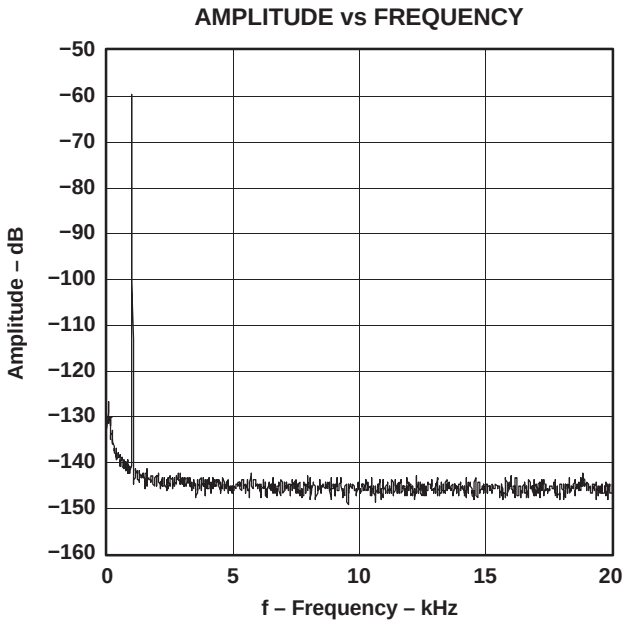


Figure 19. –60-dB Output Spectrum, BW = 20 kHz

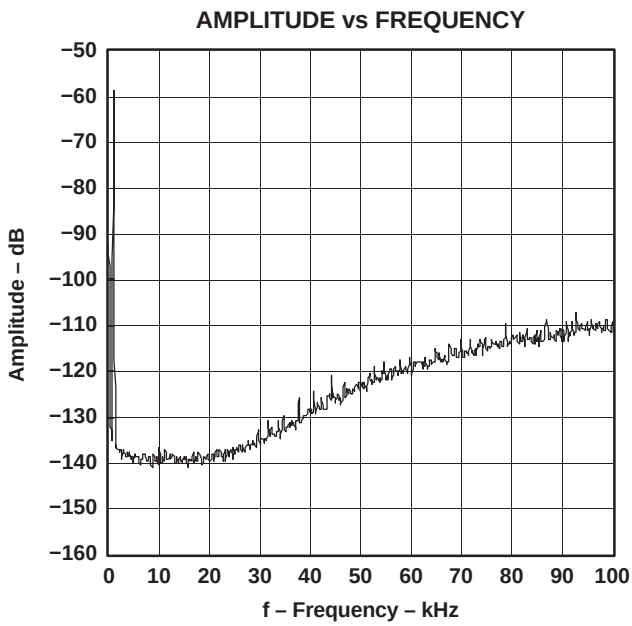


Figure 20. –60-dB Output Spectrum, BW = 100 kHz

NOTE: PCM mode, f_S = 44.1 kHz, 32768 points, 8 average, T_A = 25°C, V_{DD} = 3.3 V, V_{CC} = 5 V.

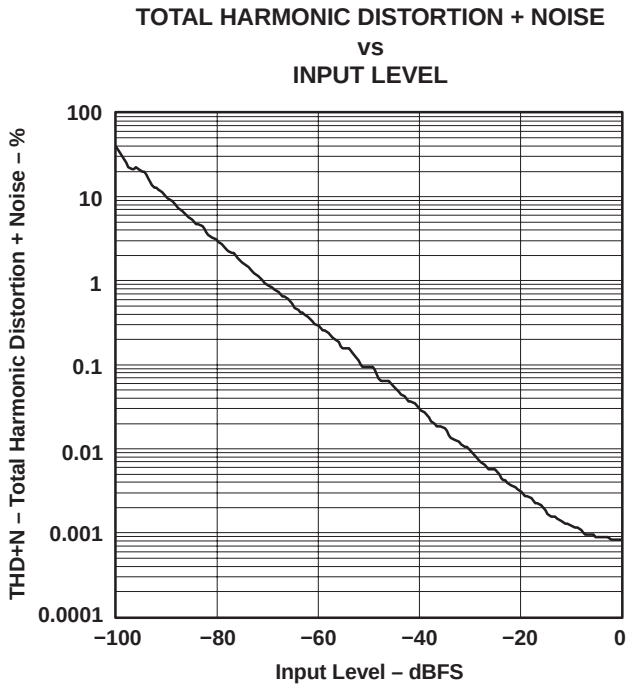


Figure 21. THD+N vs Input Level, PCM Mode

NOTE: PCM mode, f_S = 44.1 kHz, T_A = 25°C, V_{DD} = 3.3 V, V_{CC} = 5 V.

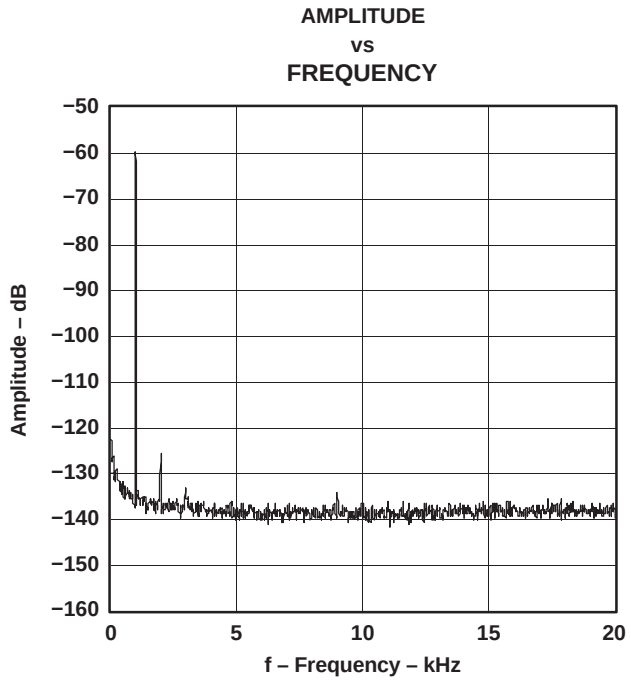


Figure 22. –60-dB Output Spectrum, DSD Mode

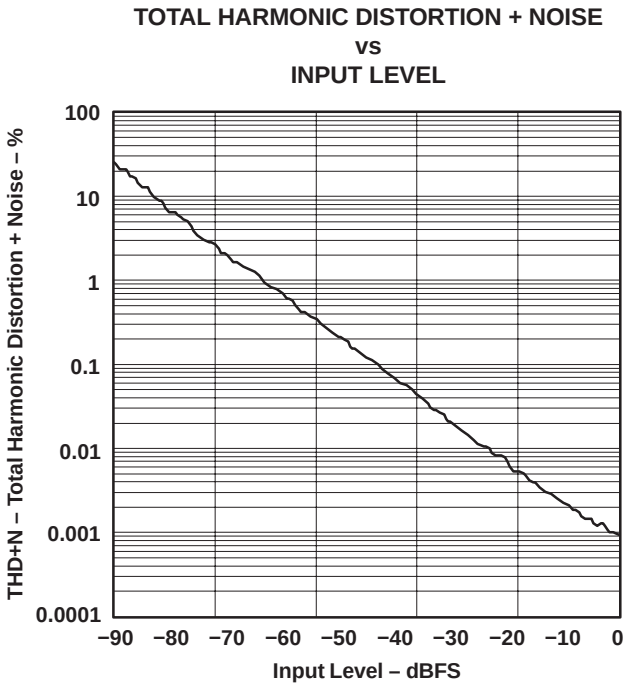


Figure 23. THD+N vs Input Level, DSD Mode

NOTE: DSD mode (FIR-2), T_A = 25°C, V_{DD} = 3.3 V, V_{CC} = 5 V.

SYSTEM CLOCK AND RESET FUNCTIONS

System Clock Input

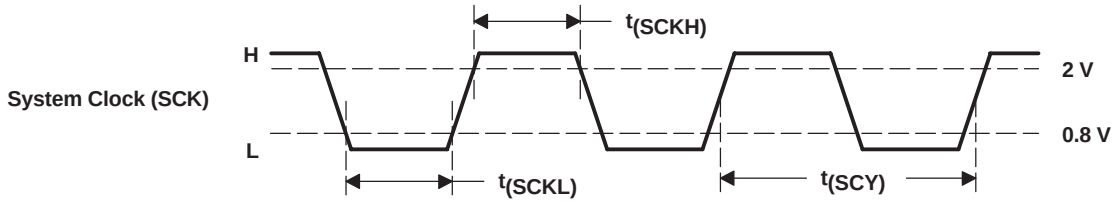
The DSD1793 requires a system clock for operating the digital interpolation filters and advanced segment DAC modulators. The system clock is applied at the SCK input (pin 5). The DSD1793 has a system clock detection circuit that automatically senses which frequency the system clock is operating. Table 1 shows examples of system clock frequencies for common audio sampling rates. If the oversampling rate of the delta-sigma modulator is selected as 128 f_S, the system clock frequency is over 256 f_S.

Figure 24 shows the timing requirements for the system clock input. For optimal performance, it is important to use a clock source with low phase jitter and noise. One of the Texas Instruments PLL1700 family of multiclock generators is an excellent choice for providing the DSD1793 system clock.

Table 1. System Clock Rates for Common Audio Sampling Frequencies

SAMPLING FREQUENCY	SYSTEM CLOCK FREQUENCY (f_{SCK}) (MHz)					
	128 f_S	192 f_S	256 f_S	384 f_S	512 f_S	768 f_S
32 kHz	4.096 (1)	6.144 (1)	8.192	12.288	16.384	24.576
44.1 kHz	5.6488 (1)	8.4672	11.2896	16.9344	22.5792	33.8688
48 kHz	6.144 (1)	9.216	12.288	18.432	24.576	36.864
96 kHz	12.288	18.432	24.576	36.864	49.152 (1)	73.728 (1)
192 kHz	24.576	36.864	49.152 (1)	73.728 (1)	(2)	(2)

(1) This system clock rate is not supported in I2C fast mode.
(2) This system clock rate is not supported for the given sampling frequency.



PARAMETERS		MIN	MAX	UNITS
$t_{(SCY)}$	System clock pulse cycle time	13		ns
$t_{(SCKH)}$	System clock pulse duration, HIGH	5		ns
$t_{(SCKL)}$	System clock pulse duration, LOW	5		ns

Figure 24. System Clock Input Timing

Power-On Reset Function

The DSD1793 includes a power-on reset function. Figure 25 shows the operation of this function. With V_{DD} > 2 V, the power-on reset function is enabled. The initialization sequence requires 1024 system clocks from the time V_{DD} > 2 V. After the initialization period, the DSD1793 is set to its default reset state, as described in the *MODE CONTROL REGISTERS* section of this data sheet.

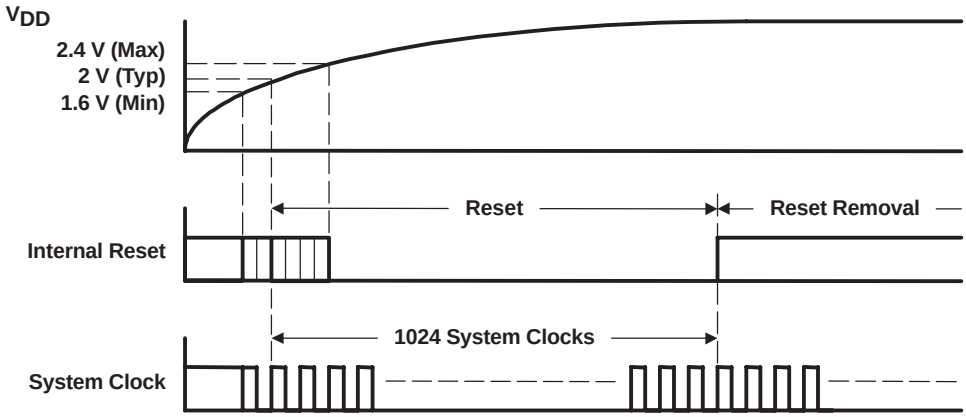


Figure 25. Power-On Reset Timing

AUDIO DATA INTERFACE

Audio Serial Interface

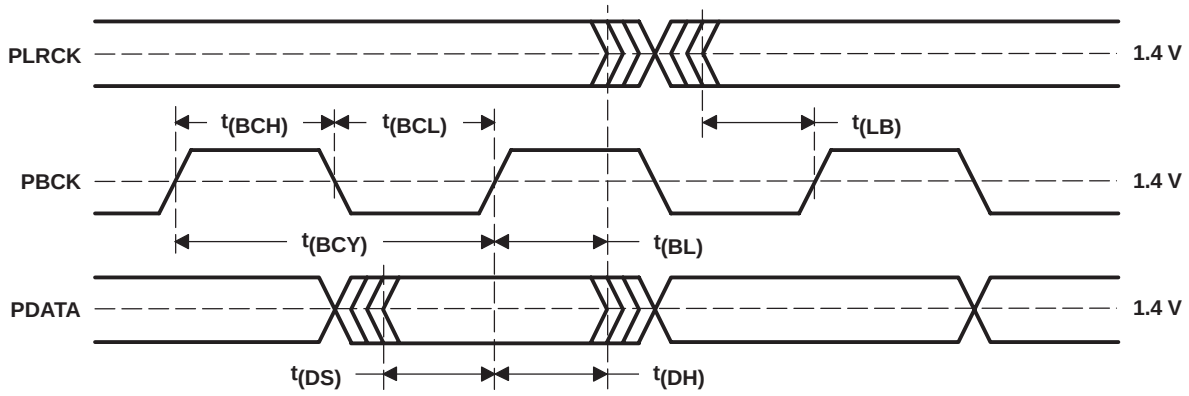
The audio interface port is a 3-wire serial port. It includes PLRCK (pin 1), PBCK (pin 2), and PDATA (pin 3). PBCK is the serial audio bit clock, and it is used to clock the serial data present on PDATA into the serial shift register of the audio interface. Serial data is clocked into the DSD1793 on the rising edge of PBCK. PLRCK is the serial audio left/right word clock.

The DSD1793 requires the synchronization of PLRCK and the system clock, but does not need a specific phase relation between PLRCK and the system clock.

If the relationship between PLRCK and the system clock changes more than ±6 PBCK, internal operation is initialized within $1/f_S$ and analog outputs are forced to the bipolar zero level until resynchronization between PLRCK and the system clock is completed.

PCM Audio Data Formats and Timing

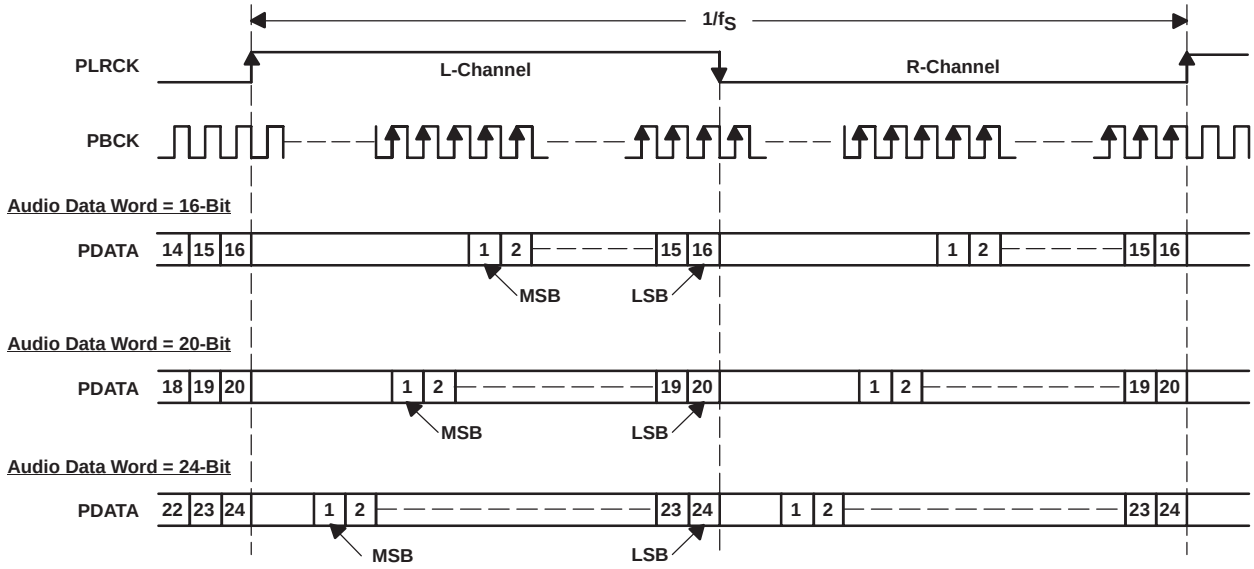
The DSD1793 supports industry-standard audio data formats, including standard right-justified, I^2S, and left-justified. The data formats are shown in Figure 27. Data formats are selected using the format bits, FMT[2:0], in control register 18. The default data format is 24-bit I^2S. All formats require binary 2s complement, MSB-first audio data. Figure 26 shows a detailed timing diagram for the serial audio interface.



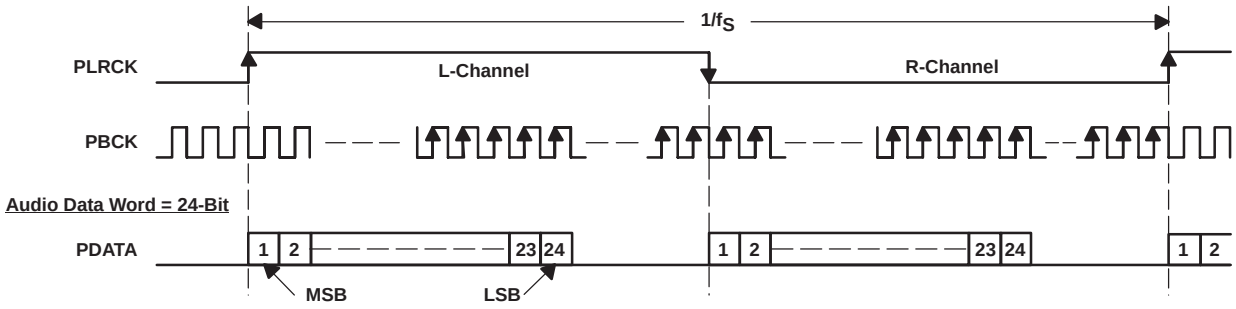
PARAMETERS		MIN	MAX	UNITS
$t_{(BCY)}$	PBCK pulse cycle time	70		ns
$t_{(BCL)}$	PBCK pulse duration, LOW	30		ns
$t_{(BCH)}$	PBCK pulse duration, HIGH	30		ns
$t_{(BL)}$	PBCK rising edge to PLRCK edge	10		ns
$t_{(LB)}$	PLRCK edge to PBCK rising edge	10		ns
$t_{(DS)}$	PDATA setup time	10		ns
$t_{(DH)}$	PDATA hold time	10		ns
—	PLRCK clock data	50% ± 2 bit clocks		

Figure 26. Timing of Audio Interface

(1) Standard Data Format (Right Justified) ; L-Channel = HIGH, R-Channel = LOW



(2) Left Justified Data Format; L-Channel = HIGH, R-Channel = LOW



(3) I2S Data Format; L-Channel = LOW, R-Channel = HIGH

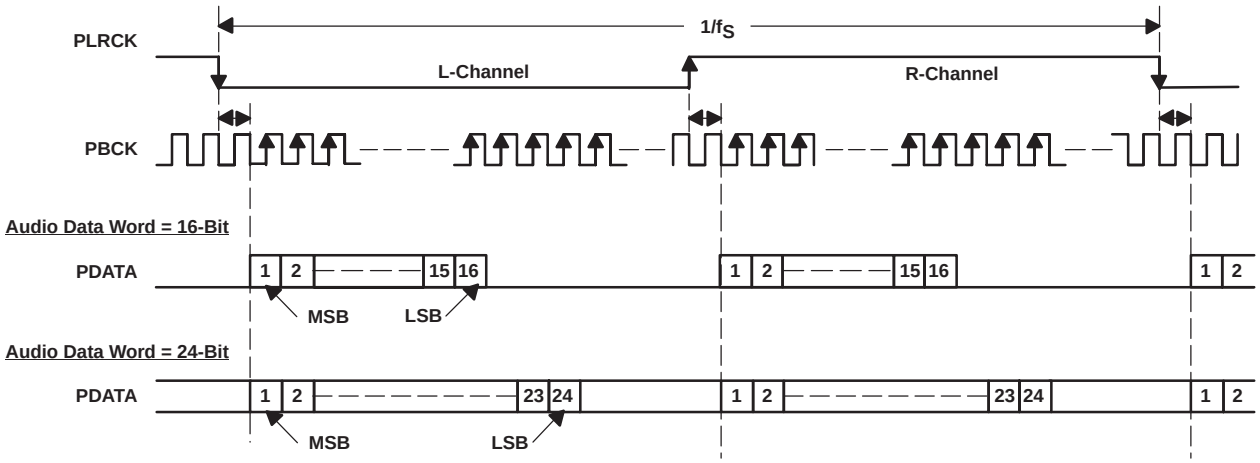


Figure 27. Audio Data Input Formats

External Digital Filter Interface and Timing

The DSD1793 supports an external digital filter interface with a 3- or 4-wire synchronous serial port, which allows the use of an external digital filter. External filters include the Texas Instruments DF1704 and DF1706, the Pacific Microsonics PMD200, or a programmable digital signal processor.

In the external DF mode, PLRCK (pin 1), PBCK (pin 2) and PDATA (pin 3) are defined as WDCK, the word clock; BCK, the bit clock; and DATA, the monaural data, respectively. The external digital filter interface is selected by using the DFTH bit of control register 20, which functions to bypass the internal digital filter of the DSD1793.

When the DFMS bit of control register 19 is set, the DSD1793 can process stereo data. In this case, DSDL (pin 25) and DSDR (pin 24) are defined as L-channel data and R-channel data input, respectively.

Detailed information for the external digital filter interface mode is provided in the *APPLICATION FOR EXTERNAL DIGITAL FILTER INTERFACE* section of this data sheet.

Direct Stream Digital (DSD) Format Interface and Timing

The DSD1793 supports the DSD format interface operation, which includes out-of-band noise filtering using an internal analog FIR filter. The DSD format interface consists of a 3-wire synchronous serial port, which includes DBCK (pin 4), DSDL (pin 25), and DSDR (pin 24). DBCK is the serial bit clock. DSDL and DSDR are L-channel and R-channel DSD data input, respectively. They are clocked into the DSD1793 on the rising edge of DBCK. PLRCK (pin 1) and PBCK (pin 2) must be connected to GND in the DSD mode. The DSD format (DSD mode) interface is activated by setting the DSD bit of control register 20.

Detailed information for the DSD mode is provided in the *APPLICATION FOR DSD FORMAT (DSD MODE) INTERFACE* section of this data sheet.

FUNCTIONAL DESCRIPTIONS

Zero Detect

The DSD1793 has a zero-detect function. When the DSD1793 detects the zero conditions as shown in Table 2, the DSD1793 sets ZEROL (pin 23) and ZEROR (pin 22) to HIGH.

Table 2. Zero Conditions

MODE		DETECTING CONDITION AND TIME
PCM		DATA is continuously LOW for 1024 LRCKs.
External DF mode		DATA is continuously LOW for 1024 WDCKs.
DSD	DZ0	There are an equal number of 1s and 0s in every 8 bits of DSD input data for 23 ms.
	DZ1	The input data is 1001 0110 continuously for 23 ms.

Serial Control Interface (I^2C)

The DSD1793 supports the I^2C serial bus and the data transmission protocol for standard and fast mode as a slave device. This protocol is explained in I^2C specification 2.0.

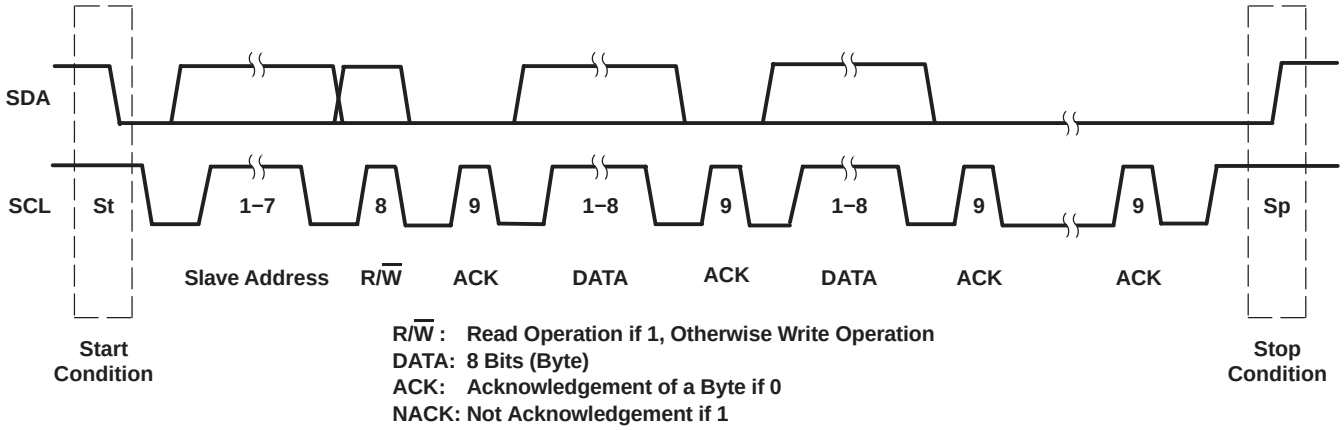
Slave Address

MSB							LSB
1	0	0	1	1	ADR1	ADR0	R/$\overline{W}$

The DSD1793 has 7 bits for its own slave address. The first five bits (MSBs) of the slave address are factory preset to 10011. The next two bits of the address byte are the device select bits, which can be user-defined by the ADR1 and ADR0 terminals. A maximum of four DSD1793s can be connected on the same bus at one time. Each DSD1793 responds when it receives its own slave address.

Packet Protocol

A master device must control packet protocol, which consists of start condition, slave address, read/write bit, data if write or acknowledge if read, and stop condition. The DSD1793 supports only slave receivers and slave transmitters.



Write operation

Transmitter	*M*	*M*	*M*	*S*	*M*	*S*	*M*	*S*	…	*S*	*M*
Data Type	St	Slave Address	$\overline{W}$	ACK	DATA	ACK	DATA	ACK	…	ACK	Sp

Read operation

Transmitter	*M*	*M*	*M*	*S*	*S*	*M*	*S*	*M*	…	*M*	*M*
Data Type	St	Slave Address	R	ACK	DATA	ACK	DATA	ACK	…	NACK	Sp

NOTE: M: Master Device S: Slave Device St: Start Condition
Sp: Stop Condition $\overline{W}$: Write R: Read

Figure 28. Basic I^2C Framework

Write Register

A master can write to any DSD1793 registers using single or multiple accesses. The master sends a DSD1793 slave address with a write bit, a register address, and the data. If multiple access is required, the address is that of the starting register, followed by the data to be transferred. When the data are received properly, the index register is incremented automatically by 1. When the index register reaches 0x7F, the next value is 0x0. When undefined registers are accessed, the DSD1793 does not send an acknowledgement. Figure 29 is a diagram of the write operation.

Transmitter	*M*	*M*	*M*	*S*	*M*	*S*	*M*	*S*	*M*	*S*	…	*S*	*M*
Data Type	St	Slave Address	$\overline{W}$	ACK	Register Address	ACK	Write Data 1	ACK	Write Data 2	ACK	…	ACK	Sp

M: Master Device *S*: Slave Device St: Start Condition
ACK: Acknowledge Sp: Stop Condition $\overline{W}$: Write

Figure 29. Write Operation

Read Register

A master can read the DSD1793 register. The value of the register address is stored in an indirect index register in advance. The master sends a DSD1793 slave address with a read bit after storing the register address. Then the DSD1793 transfers the data which the index register points to. When the data are transferred during a multiple access, the index register is incremented by 1 automatically. (When first going into read mode immediately following a write, the index register is not incremented. The master can read the register that was previously written.) When the index register reaches 0x7F, the next value is 0x0. The DSD1793 outputs some data when the index register is 0x10 to 0x1F, even if it is not defined in Table 4. Figure 30 is a diagram of the read operation.

Transmitter	*M*	*M*	*M*	*S*	*M*	*S*	*M*	*M*	*M*	*S*	*S*	*M*	…	*M*	*M*
Data Type	St	Slave Address	$\overline{W}$	ACK	Register Address	ACK	Sr	Slave Address	R	ACK	Data	ACK	…	NACK	Sp

M: Master Device *S*: Slave Device St: Start Condition Sr: Repeated Start Condition
ACK: Acknowledge Sp: Stop Condition NACK: Not Acknowledge $\overline{W}$: Write R: Read

NOTE: The slave address after the repeat start condition must be the same as the previous slave address.

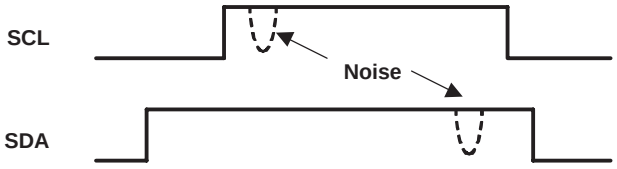
Figure 30. Read Operation

Noise Suppression

The DSD1793 incorporates noise suppression using the system clock (SCK). However, there must be no more than two noise spikes in 600 ns. The noise suppression works for SCK frequencies between 8 MHz and 40 MHz in fast mode. However, it works incorrectly in the particular following conditions.

Case 1:

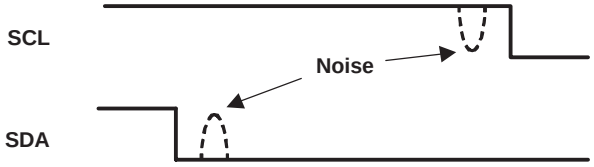
1. $t_{(SCK)} > 120$ ns ($t_{(SCK)}$: period of SCK)
2. $t_{(HI)} + t_{(D-HD)} < t_{(SCK)} \times 5$
3. Spike noise exists on the first half of the SCL HIGH pulse.
4. Spike noise exists on the SDA HIGH pulse just before SDA goes LOW.



When these conditions occur at the same time, the data is recognized as LOW.

Case 2:

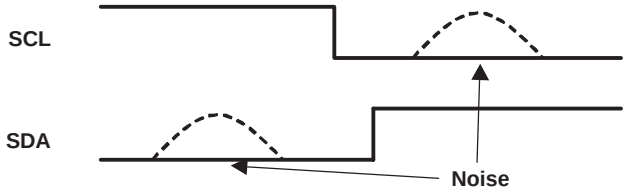
1. $t_{(SCK)} > 120$ ns
2. $t_{(S\text{-}HD)}$ or $t_{(RS\text{-}HD)} < t_{(SCK)} \times 5$
3. Spike noise exists on both SCL and SDA during the hold time.



When these conditions occur at the same time, the DSD1793 fails to detect a start condition.

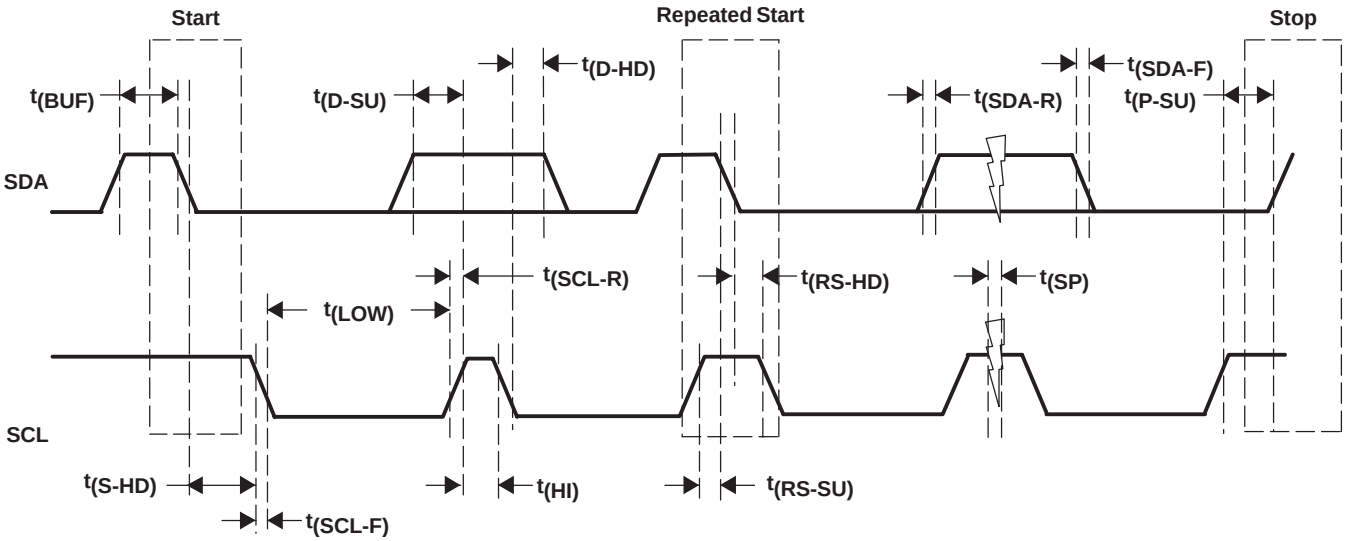
Case 3:

1. $t_{(SCK)} < 50$ ns
2. $t_{(SP)} > t_{(SCK)}$
3. Spike noise exists on SCL just after SCL goes LOW.
4. Spike noise exists on SDA just before SCL goes LOW.



When these conditions occur at the same time, the DSD1793 erroneously detects a start or stop condition.

TIMING DIAGRAM



TIMING CHARACTERISTICS

PARAMETER		CONDITIONS	MIN	MAX	UNIT
$f_{(SCL)}$	SCL clock frequency	Standard		100	kHz
		Fast		400	
$t_{(BUF)}$	Bus free time between stop and start conditions	Standard	4.7		µs
		Fast	1.3		
$t_{(LOW)}$	Low period of the SCL clock	Standard	4.7		µs
		Fast	1.3		
$t_{(HI)}$	High period of the SCL clock	Standard	4		µs
		Fast	600		ns
$t_{(RS-SU)}$	Setup time for (repeated) start condition	Standard	4.7		µs
		Fast	600		ns
$t_{(S-HD)}$	Hold time for (repeated) start condition	Standard	4		µs
$t_{(RS-HD)}$		Fast	600		ns
$t_{(D-SU)}$	Data setup time	Standard	250		ns
		Fast	100		
$t_{(D-HD)}$	Data hold time	Standard	0	900	ns
		Fast	0	900	
$t_{(SCL-R)}$	Rise time of SCL signal	Standard	$20 + 0.1\ C_B$	1000	ns
		Fast	$20 + 0.1\ C_B$	300	
$t_{(SCL-R1)}$	Rise time of SCL signal after a repeated start condition and after an acknowledge bit	Standard	$20 + 0.1\ C_B$	1000	ns
		Fast	$20 + 0.1\ C_B$	300	
$t_{(SCL-F)}$	Fall time of SCL signal	Standard	$20 + 0.1\ C_B$	1000	ns
		Fast	$20 + 0.1\ C_B$	300	
$t_{(SDA-R)}$	Rise time of SDA signal	Standard	$20 + 0.1\ C_B$	1000	ns
		Fast	$20 + 0.1\ C_B$	300	
$t_{(SDA-F)}$	Fall time of SDA signal	Standard	$20 + 0.1\ C_B$	1000	ns
		Fast	$20 + 0.1\ C_B$	300	
$t_{(P-SU)}$	Setup time for stop condition	Standard	4		µs
		Fast	600		ns
$C_{(B)}$	Capacitive load for SDA and SCL line			400	pF
$t_{(SP)}$	Pulse duration of suppressed spike	Fast		50	ns
V_{NH}	Noise margin at high level for each connected device (including hysteresis)		$0.2\ V_{DD}$		V

MODE CONTROL REGISTERS

User-Programmable Mode Controls

The DSD1793 includes a number of user-programmable functions which are accessed via mode control registers. The registers are programmed using the serial control interface, which was previously discussed in this data sheet. Table 3 lists the available mode-control functions, along with their default reset conditions and associated register index.

Table 3. User-Programmable Function Controls

FUNCTION	DEFAULT	REGISTER	BIT	PCM	DSD	DF BYPASS
Digital attenuation control 0 dB to –120 dB and mute, 0.5 dB step	0 dB	Register 16 Register 17	ATL[7:0] (for L-ch) ATR[7:0] (for R-ch)	yes		
Attenuation load control—Disabled, enabled	Attenuation disabled	Register 18	ATLD	yes		
Input audio data format selection 16-, 20-, 24-bit standard (right-justified) format 24-bit MSB-first left-justified format 16-/24-bit I^2S format	24-bit I^2S format	Register 18	FMT[2:0]	yes		yes
Sampling rate selection for de-emphasis Disabled, 44.1 kHz, 48 kHz, 32 kHz	De-emphasis disabled	Register 18	DMF[1:0]	yes	yes(1)	
De-emphasis control—Disabled, enabled	De-emphasis disabled	Register 18	DME	yes		
Soft mute control—Mute disabled, enabled	Mute disabled	Register 18	MUTE	yes		
Output phase reversal—Normal, reverse	Normal	Register 19	REV	yes	yes	yes
Attenuation speed selection $\times 1\ f_S$, $\times(1/2)f_S$, $\times(1/4)f_S$, $\times(1/8)f_S$	$\times 1\ f_S$	Register 19	ATS[1:0]	yes		
DAC operation control—Enabled, disabled	DAC operation enabled	Register 19	OPE	yes	yes	yes
Stereo DF bypass mode select Monaural, stereo	Monaural	Register 19	DFMS			yes
Digital filter rolloff selection Sharp rolloff, slow rolloff	Sharp rolloff	Register 19	FLT	yes		
Infinite zero mute control Disabled, enabled	Disabled	Register 19	INZD	yes		yes
System reset control Reset operation , normal operation	Normal operation	Register 20	SRST	yes	yes	yes
DSD interface mode control DSD enabled, disabled	Disabled	Register 20	DSD	yes	yes	
Digital-filter bypass control DF enabled, DF bypass	DF enabled	Register 20	DFTH	yes		yes
Monaural mode selection Stereo, monaural	Stereo	Register 20	MONO	yes	yes	yes
Channel selection for monaural mode data L-channel, R-channel	L-channel	Register 20	CHSL	yes	yes	yes
Delta-sigma oversampling rate selection $\times 64\ f_S$, $\times 128\ f_S$, $\times 32\ f_S$	$\times 64\ f_S$	Register 20	OS[1:0]	yes	yes(2)	yes
PCM zero output enable	Enabled	Register 21	PCMZ	yes		yes
DSD zero output enable	Disabled	Register 21	DZ[1:0]		yes	
Function Available Only For Read						
Zero detection flag Not zero, zero detected	Not zero = 0 Zero detected = 1	Register 22	ZFGL (for L-ch) ZFGR (for R-ch)	yes	yes	yes

(1) When in DSD mode, DMF[1:0] is defined as DSD filter (analog FIR) performance selection.
(2) When in DSD mode, OS[1:0] is defined as DSD filter (analog FIR) operation rate selection.

Register Map

The mode control register map is shown in Table 4. Registers 16–21 include an R/$\overline{W}$ bit, which determines whether a register read (R/$\overline{W}$ = 1) or write (R/$\overline{W}$ = 0) operation is performed. Register 22 is read-only.

Table 4. Mode Control Register Map

	B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1	B0
Register 16	R/$\overline{W}$	0	0	1	0	0	0	0	ATL7	ATL6	ATL5	ATL4	ATL3	ATL2	ATL1	ATL0
Register 17	R/$\overline{W}$	0	0	1	0	0	0	1	ATR7	ATR6	ATR5	ATR4	ATR3	ATR2	ATR1	ATR0
Register 18	R/$\overline{W}$	0	0	1	0	0	1	0	ATLD	FMT2	FMT1	FMT0	DMF1	DMF0	DME	MUTE
Register 19	R/$\overline{W}$	0	0	1	0	0	1	1	REV	ATS1	ATS0	OPE	RSV	DFMS	FLT	INZD
Register 20	R/$\overline{W}$	0	0	1	0	1	0	0	RSV	SRST	DSD	DFTH	MONO	CHSL	OS1	OS0
Register 21	R/$\overline{W}$	0	0	1	0	1	0	1	RSV	RSV	RSV	RSV	RSV	DZ1	DZ0	PCMZ
Register 22	R	0	0	1	0	1	1	0	RSV	RSV	RSV	RSV	RSV	RSV	ZFGR	ZFGL

Register Definitions

	B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1	B0
Register 16	R/$\overline{W}$	0	0	1	0	0	0	0	ATL7	ATL6	ATL5	ATL4	ATL3	ATL2	ATL1	ATL0
Register 17	R/$\overline{W}$	0	0	1	0	0	0	1	ATR7	ATR6	ATR5	ATR4	ATR3	ATR2	ATR1	ATR0

R/$\overline{W}$: Read/Write Mode Select

When R/$\overline{W}$ = 0, a write operation is performed.

When R/$\overline{W}$ = 1, a read operation is performed.

Default value: 0

ATx[7:0]: Digital Attenuation Level Setting

These bits are available for read and write.

Default value: 1111 1111b

Each DAC output has a digital attenuator associated with it. The attenuator can be set from 0 dB to –120 dB, in 0.5-dB steps. Alternatively, the attenuator can be set to infinite attenuation (or mute).

The attenuation data for each channel can be set individually. However, the data load control (the ATLD bit of control register 18) is common to both attenuators. ATLD must be set to 1 in order to change an attenuator setting. The attenuation level can be set using the following formula:

$$\text{Attenuation level (dB)} = 0.5\ \text{dB} \bullet (\text{ATx}[7:0]_{DEC} - 255)$$

where $\text{ATx}[7:0]_{DEC}$ = 0 through 255

For $\text{ATx}[7:0]_{DEC}$ = 0 through 14, the attenuator is set to infinite attenuation. The following table shows attenuation levels for various settings:

ATx[7:0]	Decimal Value	Attenuation Level Setting
1111 1111b	255	0 dB, no attenuation (default)
1111 1110b	254	–0.5 dB
1111 1101b	253	–1.0 dB
⋮	⋮	⋮
0001 0000b	16	–119.5 dB
0000 1111b	15	–120.0 dB
0000 1110b	14	Mute
⋮	⋮	⋮
0000 0000b	0	Mute

	B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1	B0
Register 18	R/$\overline{W}$	0	0	1	0	0	1	0	ATLD	FMT2	FMT1	FMT0	DMF1	DMF0	DME	MUTE

R/$\overline{W}$: Read/Write Mode Select

When R/$\overline{W}$ = 0, a write operation is performed.

When R/$\overline{W}$ = 1, a read operation is performed.

Default value: 0

ATLD: Attenuation Load Control

This bit is available for read and write.

Default value: 0

ATLD = 0	Attenuation control disabled (default)
ATLD = 1	Attenuation control enabled

The ATLD bit enables loading of the attenuation data contained in registers 16 and 17. When ATLD = 0, the attenuation settings remain at the previously programmed levels, ignoring new data loaded from registers 16 and 17. When ATLD = 1, attenuation data written to registers 16 and 17 is loaded normally.

FMT[2:0]: Audio Interface Data Format

These bits are available for read and write.

Default value: 101

FMT[2:0]	Audio Data Format Selection
000	16-bit standard format, right-justified data
001	20-bit standard format, right-justified data
010	24-bit standard format, right-justified data
011	24-bit MSB-first, left-justified format data
100	16-bit I^2S-format data
101	24-bit I^2S-format data (default)
110	Reserved
111	Reserved

The FMT[2:0] bits select the data format for the serial audio interface.

For the external digital filter interface mode (DFTH mode), this register is operated as shown in the *APPLICATION FOR EXTERNAL DIGITAL FILTER INTERFACE* section of this data sheet.

DMF[1:0]: Sampling Frequency Selection for the De-Emphasis Function

These bits are available for read and write.

Default value: 00

DMF[1:0]	De-Emphasis Sampling Frequency Selection
00	Disabled (default)
01	48 kHz
10	44.1 kHz
11	32 kHz

The DMF[1:0] bits select the sampling frequency used by the digital de-emphasis function when it is enabled by setting the DME bit. The de-emphasis curves are shown in the *TYPICAL PERFORMANCE CURVES* section of this data sheet.

For the DSD mode, analog FIR filter performance can be selected using this register. A register map and filter response plots are shown in the *APPLICATION FOR DSD FORMAT (DSD MODE) INTERFACE* section of this data sheet.

DME: Digital De-Emphasis Control

This bit is available for read and write.

Default value: 0

DME = 0	De-emphasis disabled (default)
DME = 1	De-emphasis enabled

The DME bit enables or disables the de-emphasis function for both channels.

MUTE: Soft Mute Control

This bit is available for read and write.

Default value: 0

MUTE = 0	MUTE disabled (default)
MUTE = 1	MUTE enabled

The MUTE bit enables or disables the soft mute function for both channels.

Soft mute is operated as a 256-step attenuator. The speed for each step to –∞ dB (mute) is determined by the attenuation rate selected in the ATS register.

	B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1	B0
Register 19	R/$\overline{W}$	0	0	1	0	0	1	1	REV	ATS1	ATS0	OPE	RSV	DFMS	FLT	INZD

R/$\overline{W}$: Read/Write Mode Select

When R/$\overline{W}$ = 0, a write operation is performed.

When R/$\overline{W}$ = 1, a read operation is performed.

Default value: 0

REV: Output Phase Reversal

This bit is available for read and write.

Default value: 0

REV = 0	Normal output (default)
REV = 1	Inverted output

The REV bit inverts the output phase for both channels.

ATS[1:0]: Attenuation Rate Select

These bits are available for read and write.

Default value: 00

ATS[1:0]	Attenuation Rate Selection
00	Every PLRCK (default)
01	PLRCK/2
10	PLRCK/4
11	PLRCK/8

The ATS[1:0] bits select the rate at which the attenuator is decremented/incremented during level transitions.

OPE: DAC Operation Control

This bit is available for read and write.

Default value: 0

OPE = 0	DAC operation enabled (default)
OPE = 1	DAC operation disabled

The OPE bit enables or disables the analog output for both channels. Disabling the analog outputs forces them to the bipolar zero level (BPZ) even if digital audio data is present on the input.

DFMS: Stereo DF Bypass Mode Select

This bit is available for read and write.

Default value: 0

DFMS = 0	Monaural (default)
DFMS = 1	Stereo input enabled

The DFMS bit enables stereo operation in the DF bypass mode. In the DF bypass mode, when DFMS is set to 0, the pin for the input data is PDATA (pin 3) only, therefore the DSD1793 operates as a monaural DAC. When DFMS is set to 1, the DSD1793 can operate as a stereo DAC with inputs of L-channel and R-channel data on DSDL (pin 25) and DSDR (pin 24), respectively.

FLT: Digital Filter Rolloff Control

This bit is available for read and write.

Default value: 0

FLT = 0	Sharp rolloff (default)
FLT = 1	Slow rolloff

The FLT bit selects the digital filter rolloff characteristic. The filter responses for these selections are shown in the *TYPICAL PERFORMANCE CURVES* section of this data sheet.

INZD: Infinite Zero Detect Mute Control

This bit is available for read and write.

Default value: 0

INZD = 0	Infinite zero detect mute disabled (default)
INZD = 1	Infinite zero detect mute enabled

The INZD bit enables or disables the zero detect mute function. Setting INZD to 1 forces muted analog outputs to hold a bipolar zero level when the DSD1793 detects zero condition in both channels. The infinite zero detect mute function is not available in the DSD mode.

	B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1	B0
Register 20	R/$\overline{W}$	0	0	1	0	1	0	0	RSV	SRST	DSD	DFTH	MONO	CHSL	OS1	OS0

R/$\overline{W}$: Read/Write Mode Select

When R/$\overline{W}$ = 0, a write operation is performed.

When R/$\overline{W}$ = 1, a read operation is performed.

Default value: 0

SRST: System Reset Control

This bit is available for write only.

Default value: 0

SRST = 0	Normal operation (default)
SRST = 1	System reset operation (generate one reset pulse)

The SRST bit resets the DSD1793 to the initial system condition.

DSD: DSD Interface Mode Control

This bit is available for read and write.

Default value: 0

DSD = 0	DSD interface mode disabled (default)
DSD = 1	DSD interface mode enabled

The DSD bit enables or disables the DSD interface mode.

DFTH: Digital Filter Bypass (or Through Mode) Control

This bit is available for read and write.

Default value: 0

DFTH = 0	Digital filter enabled (default)
DFTH = 1	Digital filter bypassed for the external digital filter

The DFTH bit enables or disables the external digital filter interface mode.

MONO: Monaural Mode Selection

This bit is available for read and write.

Default value: 0

MONO = 0	Stereo mode (default)
MONO = 1	Monaural mode

The MONO function changes the operation mode from the normal stereo mode to the monaural mode. When the monaural mode is selected, both DACs operate in a balanced mode for one channel of audio input data. Channel selection is available for L-channel or R-channel data, determined by the CHSL bit as described immediately following.

CHSL: Channel Selection for Monaural Mode

This bit is available for read and write.

Default value: 0

CHSL = 0	L-channel selected (default)
CHSL = 1	R-channel selected

This bit is available when MONO = 1.

The CHSL bit selects L-channel or R-channel data to be used in monaural mode.

OS[1:0]: Delta-Sigma Oversampling Rate Selection

These bits are available for read and write.

Default value: 00

OS[1:0]	Operation Speed Select
00	64 times f_S (default)
01	32 times f_S
10	128 times f_S
11	Reserved

The OS bits change the oversampling rate of delta-sigma modulation. Use of this function enables the designer to stabilize the conditions at the post low-pass filter for different sampling rates. As an application example, programming to set 128 times in 44.1-kHz operation, 64 times in 96-kHz operation, and 32 times in 192-kHz operation allows the use of only a single type (cutoff frequency) of post low-pass filter. The 128-f_S oversampling rate is not available at sampling rates above 100 kHz. If the 128-f_S oversampling rate is selected, a system clock of more than 256 f_S is required.

In DSD mode, these bits select the speed of the bit clock for DSD data coming into the analog FIR filter.

	B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1	B0
Register 21	R/$\overline{W}$	0	0	1	0	1	0	1	RSV	RSV	RSV	RSV	RSV	DZ1	DZ0	PCMZ

R/$\overline{W}$: Read/Write Mode Select

When R/$\overline{W}$ = 0, a write operation is performed.

When R/$\overline{W}$ = 1, a read operation is performed.

Default value: 0

DZ[1:0]: DSD Zero Output Enable

These bits are available for read and write.

Default value: 00

DZ[1:0]	Zero Output Enable
00	Disabled (default)
01	Even pattern detect
1x	96_H pattern detect

The DZ bits enable or disable the output zero flags, and select the zero pattern in the DSD mode.

PCMZ: PCM Zero Output Enable

This bit is available for read and write.

Default value: 1

PCMZ = 0	PCM zero output disabled
PCMZ = 1	PCM zero output enabled (default)

The PCMZ bit enables or disables the output zero flags in the PCM mode and the external DF mode.

	B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1	B0
Register 22	R	0	0	1	0	1	1	0	RSV	RSV	RSV	RSV	RSV	RSV	ZFGR	ZFGL

R: Read Mode Select

Value is always 1, specifying the readback mode.

ZFGx: Zero-Detection Flag

Where x = L or R, corresponding to the DAC output channel. These bits are available only for readback.

Default value: 00

ZFGx = 0	Not zero
ZFGx = 1	Zero detected

These bits show zero conditions. Their status is the same as that of the zero flags on ZEROL (pin 23) and ZEROR (pin 22). See *Zero Detect* in the *FUNCTIONAL DESCRIPTIONS* section of this data sheet.

TYPICAL CONNECTION DIAGRAM

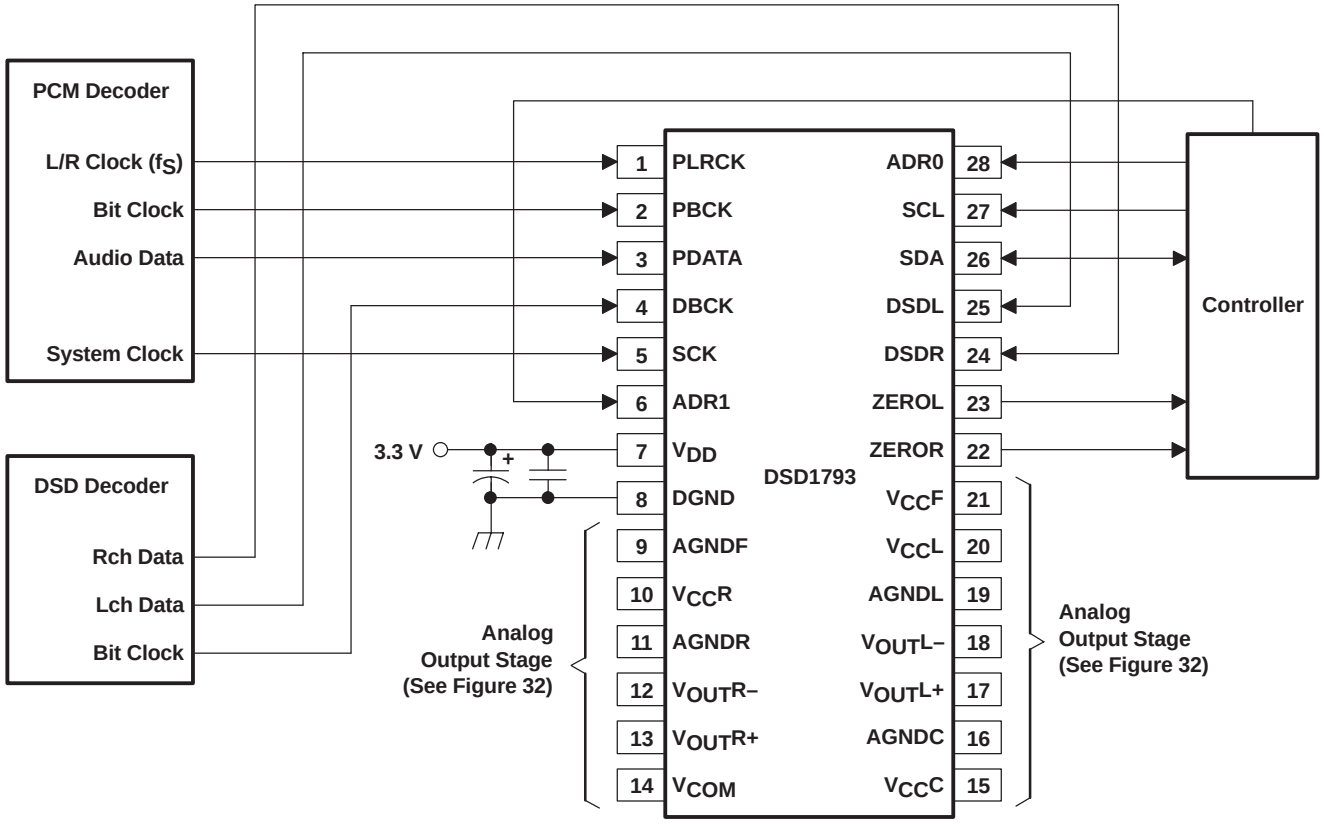
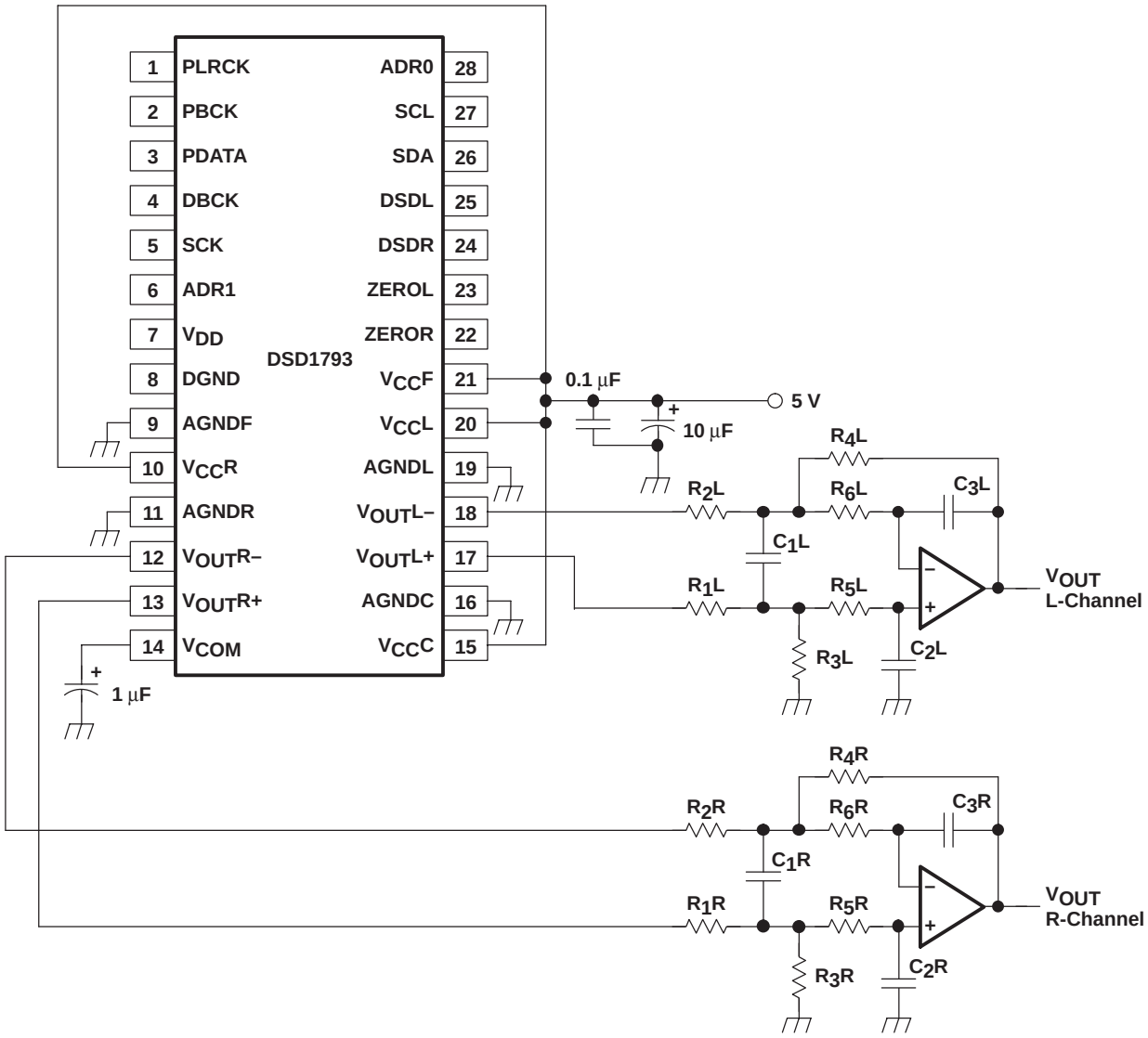


Figure 31. Typical Application Circuit

APPLICATION INFORMATION

ANALOG OUTPUTS



NOTE: Example R and C values for f_C = 77 kHz – R_1, R_2: 1.8 kΩ, R_3,R_4: 3.3 kΩ, R_5,R_6: 680 Ω, C_1: 1800 pF, C_2, C_3: 560 pF.

Figure 32. Typical Application for Analog Output Stage

Analog Output Level and LPF

The signal level of the DAC differential-voltage output {(V_{OUT}L+)–(V_{OUT}L–), (V_{OUT}R+)–(V_{OUT}R–)} is 3.2 V p-p at 0 dB (full scale). The voltage output of the LPF is given by following equation:

V_{OUT} = 3.2 V p-p × (R_f/R_i)

Here, R_f is the feedback resistor in the LPF, and R_3 = R_4 in a typical application circuit. R_i is the input resistor in the LPF, and R_1 = R_2 in a typical application circuit.

Operational Amplifier for LPF

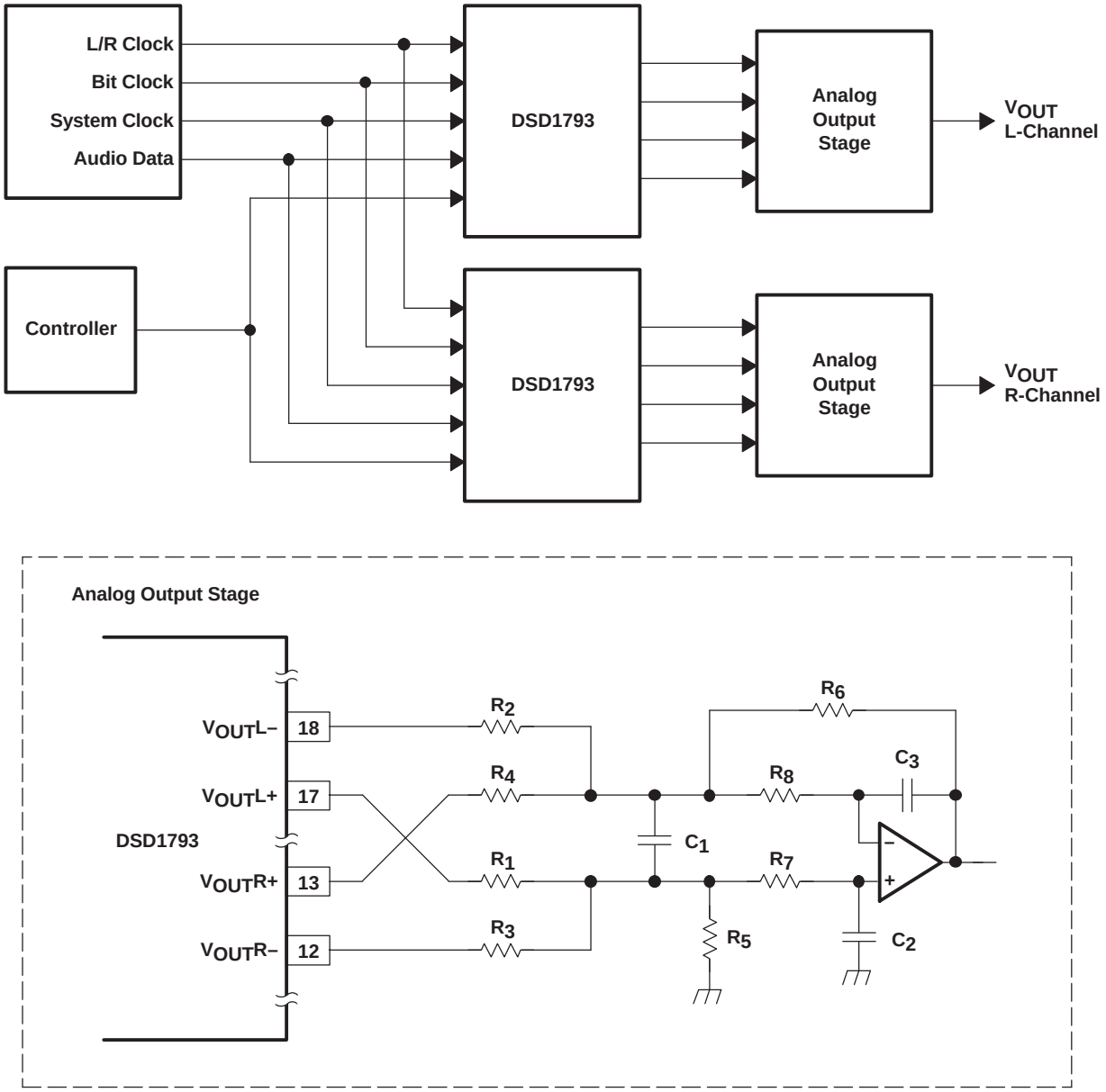
An OPA2134 or 5532 type operational amplifier is recommended for the LPF circuit to obtain the specified audio performance. Dynamic performance such as gain bandwidth, settling time, and slew rate of the operational amplifier largely determines the audio dynamic performance of the LPF section. The input noise specification of the operational amplifier should be considered to obtain a 113-dB S/N ratio.

Analog Gain of Balanced Amplifier

The DAC voltage outputs are followed by balanced amplifier stages, which sum the differential signals for each channel, creating a single-ended voltage output. In addition, the balanced amplifiers provide a third-order low-pass filter function, which band limits the audio output signal. The cutoff frequency and gain are determined by external R and C component values. In this case, the cutoff frequency is 77 kHz with a gain of 1.83. The output voltage for each channel is 5.9 V p-p, or 2.1 V rms.

Application for Monaural-Mode Operation

A single-channel signal from the stereo audio data input is output from both $V_{OUT}L$ and $V_{OUT}R$ as a differential output. The channel to be output is selected by setting the CHSL bit in register 20. The advantage of monaural operation is to provide over 115 dB of dynamic range for high-end audio applications.



NOTE: Example R and C values for f_C = 77 kHz, R1–R4: 3.6 kΩ, R5, R6: 3.3 kΩ, R7, R8: 680 Ω, C1: 1800 pF, C2, C3: 560 pF.

Figure 33. Connection Diagram for Monaural Mode Interface

APPLICATION FOR EXTERNAL DIGITAL FILTER INTERFACE

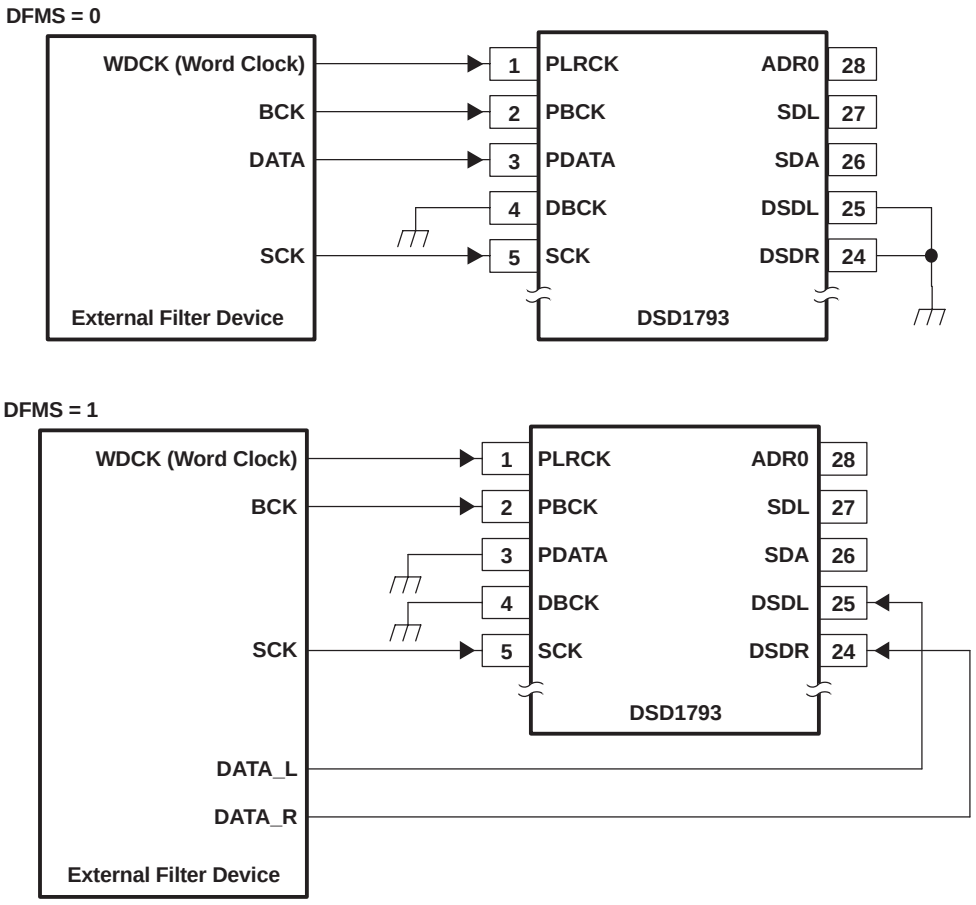


Figure 34. Connection Diagram for External DIgital Filter (Internal DF Bypass Mode) Application

Application for Interfacing With an External Digital Filter

For some applications, it may be desirable to use an external digital filter to perform the interpolation function, as it can provide improved stop-band attenuation when compared to the internal digital filter of the DSD1793.

The DSD1793 supports several external digital filters, including:

- Texas Instruments DF1704 and DF1706
- Pacific Microsonics PMD200 HDCD filter/decoder IC
- Programmable digital signal processors

The external digital filter application mode is accessed by programming the following bit in the corresponding control register:

- DFTH = 1 (register 20)

The pins used to provide the serial interface for the external digital filter are shown in the connection diagram of Figure 34. The word clock (WDCK) signal must be operated at 8× or 4× the desired sampling frequency, f_S.

Pin Assignments When Using the External Digital Filter Interface

- PLRCK (pin 1): WDCK as word clock input
- PBCK (pin 2): BCK as bit clock for audio data
- PDATA (pin 3): DATA as monaural audio data input when the DFMS bit is not set to 1
- DSDL (pin 25): DATAL as L-channel audio data input when the DFMS bit is set to 1
- DSDR (pin 24): DATAR as R-channel audio data input when the DFMS bit is set to 1

Audio Format

The DSD1793 in the external digital filter interface mode supports right-justified audio formats including 16-bit, 20-bit, and 24-bit audio data, as shown in Figure 35. The audio format is selected by the FMT[2:0] bits of control register 18.

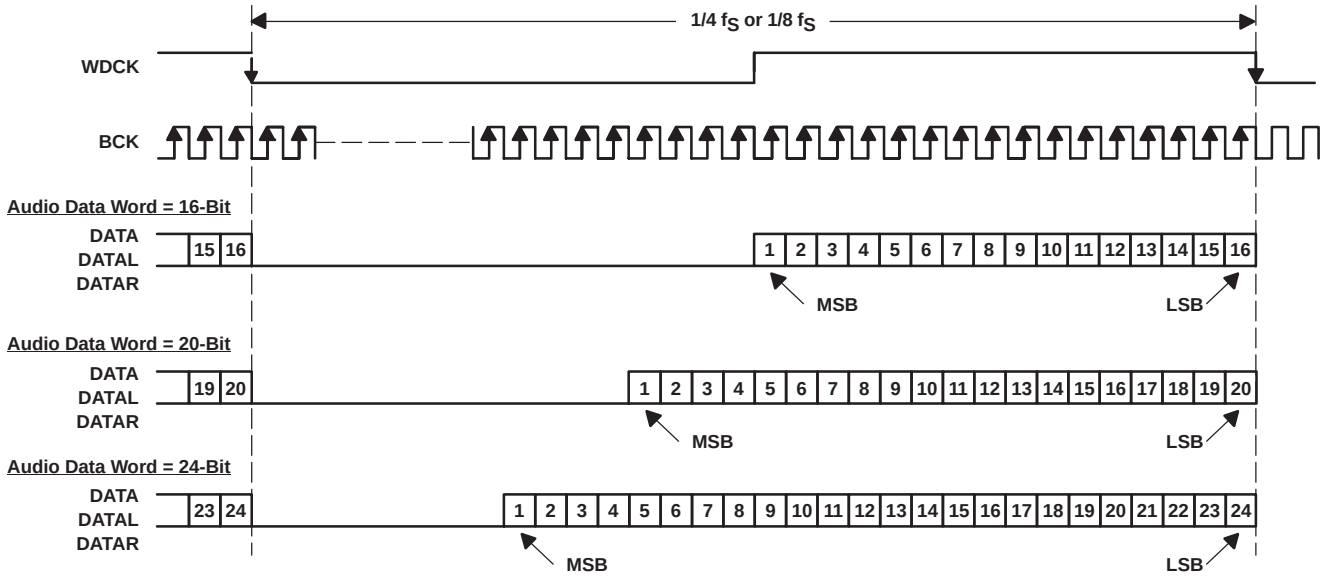
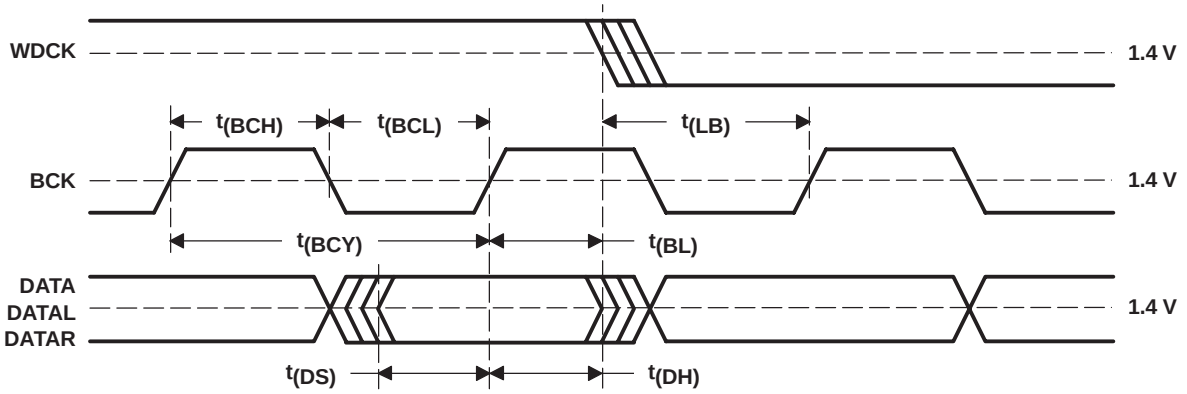


Figure 35. Audio Data Input Format for External Digital Filter (Internal DF Bypass Mode) Application

System Clock (SCK) and Interface Timing

The DSD1793 in an application using an external digital filter requires the synchronization of WDCK and the system clock. The system clock is phase-free with respect to WDCK. Interface timing among WDCK, BCK, DATA, DATAL, and DATAR is shown in Figure 36.



PARAMETER		MIN	MAX	UNITS
$t_{(BCY)}$	BCK pulse cycle time	20		ns
$t_{(BCL)}$	BCK pulse duration, LOW	7		ns
$t_{(BCH)}$	BCK pulse duration, HIGH	7		ns
$t_{(BL)}$	BCK rising edge to WDCK falling edge	5		ns
$t_{(LB)}$	WDCK falling edge to BCK rising edge	5		ns
$t_{(DS)}$	DATA, DATAL, DATAR setup time	5		ns
$t_{(DH)}$	DATA, DATAL, DATAR hold time	5		ns

Figure 36. Audio Interface Timing for External Digital Filter (Internal DF Bypass Mode) Application

Functions Available in the External Digital Filter Mode

The external digital filter mode allows access to the majority of the DSD1793 mode control functions.

The following table shows the register mapping available when the external digital filter mode is selected, along with descriptions of functions which are modified when using this mode selection.

	B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1	B0
Register 16	R/$\overline{W}$	0	0	1	0	0	0	0	–	–	–	–	–	–	–	–
Register 17	R/$\overline{W}$	0	0	1	0	0	0	1	–	–	–	–	–	–	–	–
Register 18	R/$\overline{W}$	0	0	1	0	0	1	0	–	FMT2	FMT1	FMT0	–	–	–	–
Register 19	R/$\overline{W}$	0	0	1	0	0	1	1	REV	–	–	OPE	–	DFMS	–	INZD
Register 20	R/$\overline{W}$	0	0	1	0	1	0	0	–	SRST	0	1	MONO	CHSL	OS1	OS0
Register 21	R/$\overline{W}$	0	0	1	0	1	0	1	–	–	–	–	–	–	–	PCMZ
Register 22	R	0	0	1	0	1	1	0	–	–	–	–	–	–	ZFGR	ZFGL

NOTE: –: Function is disabled. No operation even if data bit is set

FMT[2:0]: Audio Data Format Selection

Default value: 000

FMT[2:0]	Audio Data Format Select
000	16-bit right-justified format (default)
001	20-bit right-justified format
010	24-bit right-justified format
Other	N/A

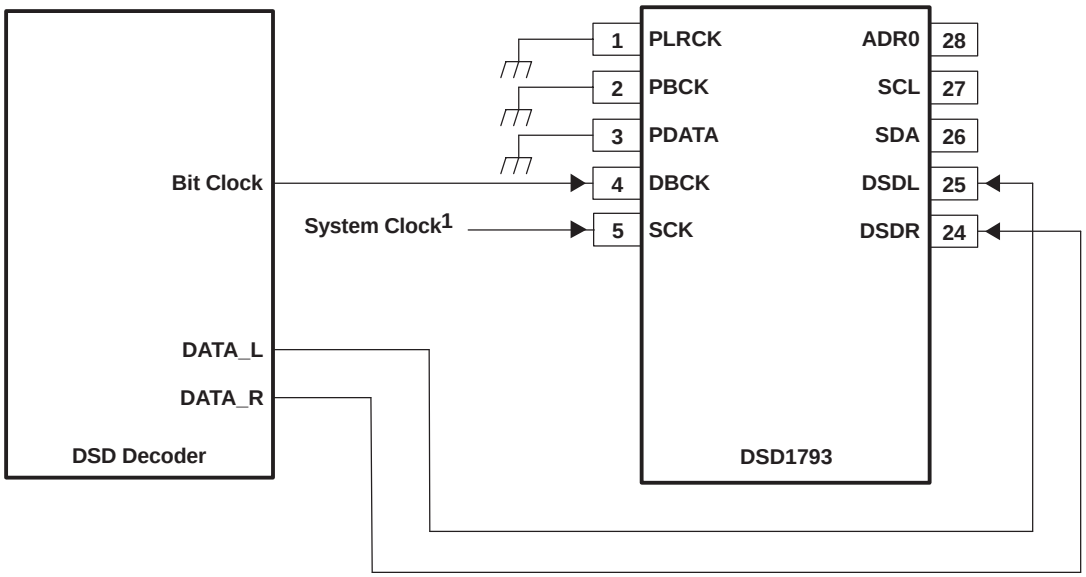
OS[1:0]: Delta-Sigma Modulator Oversampling Rate Selection

Default value: 00

OS[1:0]	Operation Speed Select
00	8 times WDCK (default)
01	4 times WDCK
10	16 times WDCK
11	Reserved

The effective oversampling rate is determined by the oversampling performed by both the external digital filter and the delta-sigma modulator. For example, if the external digital filter is 8× oversampling, and the user selects OS[1:0] = 00, then the delta-sigma modulator oversamples by 8×, resulting in an effective oversampling rate of 64×. The 16× WDCK oversampling rate is not available above a 100-kHz sampling rate. If the oversampling rate selected is 16× WDCK, the system clock frequency must be over 256 f_S.

APPLICATION FOR DSD FORMAT (DSD MODE) INTERFACE



(1) The system clock is necessary for the initialization sequence and the I2C interface operation.

Figure 37. Connection Diagram in DSD Mode

Feature

This mode is used for interfacing directly to a DSD decoder, which is found in Super Audio CD™ (SACD) applications.

The DSD mode is accessed by programming the following bit in the corresponding control register:

- DSD = 1 (register 20)

The DSD mode provides a low-pass filtering function. The filtering is provided using an analog FIR filter structure. Four FIR responses are available, and are selected via DMF[1:0] of control register 18.

Pin Assignment When Using the DSD Format Interface

- DSDL (pin 25): L-channel DSD data input
- DSDR (pin 24): R-channel DSD data input
- DBCK (pin 4): Bit clock (BCK) for DSD data

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Requirements for Bit Clock and System Clock

The bit clock (DBCK) for DSD mode is required at pin 4 of the DSD1793. The frequency of the bit clock can be N times the sampling frequency. Generally, N is 64 in DSD applications.

The interface timing between the bit clock and DSDL, DSDR is required to meet the setup and hold time specifications shown in Figure 39.

The system clock is necessary for the initialization sequence and the I^2C interface operation.

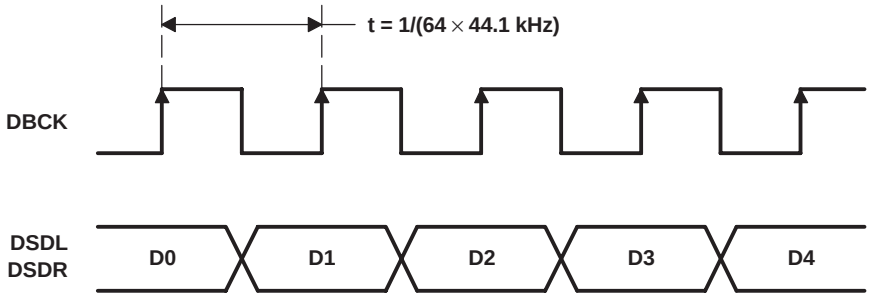
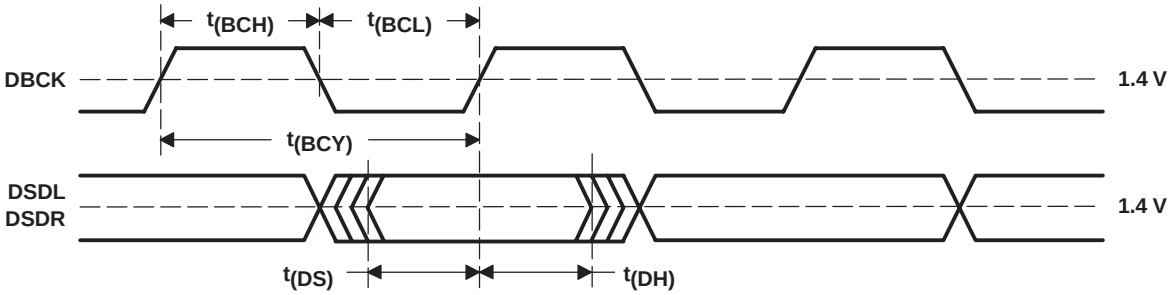


Figure 38. Normal Data Output Form From DSD Decoder



PARAMETER		MIN	MAX	UNITS
$t_{(BCY)}$	DBCK pulse cycle time	85(1)		ns
$t_{(BCH)}$	DBCK high-level time	30		ns
$t_{(BCL)}$	DBCK low-level time	30		ns
$t_{(DS)}$	DSDL, DSDR setup time	10		ns
$t_{(DH)}$	DSDL, DSDR hold time	10		ns

(1) 2.8224 MHz × 4. (2.8224 MHz = 64 × 44.1 kHz. This value is specified as a sampling rate of DSD.)

Figure 39. Timing for DSD Audio Interface

ANALOG FIR FILTER PERFORMANCE IN DSD MODE

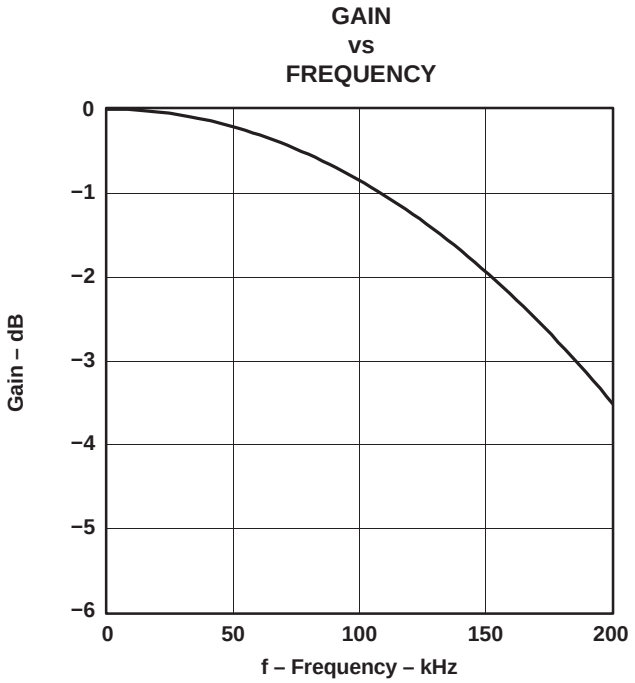


Figure 40. DSD Filter-1, Low BW

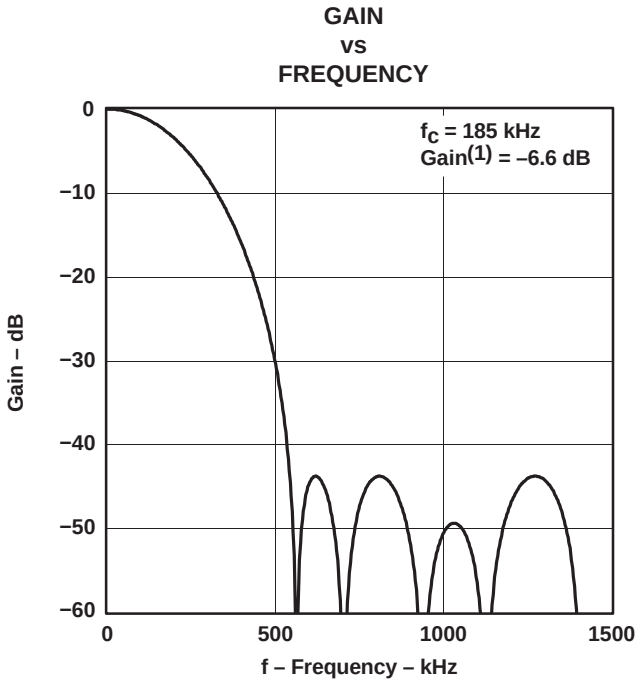


Figure 41. DSD Filter-1, High BW

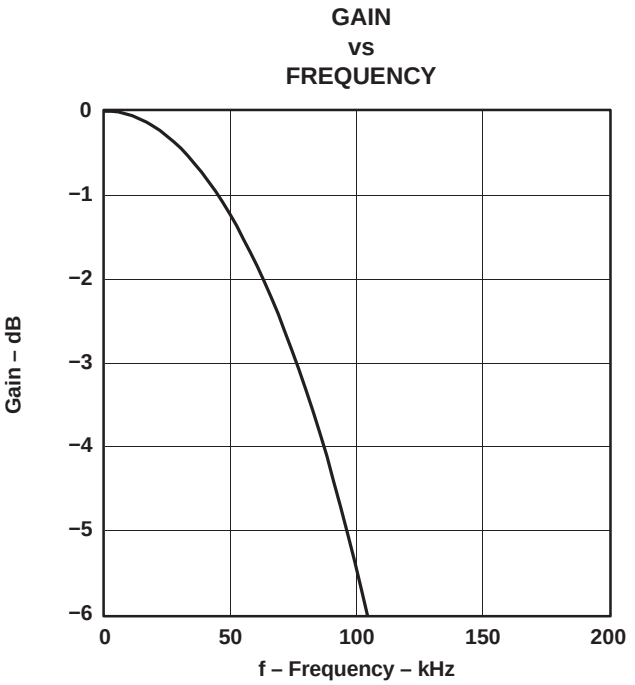


Figure 42. DSD Filter-2, Low BW

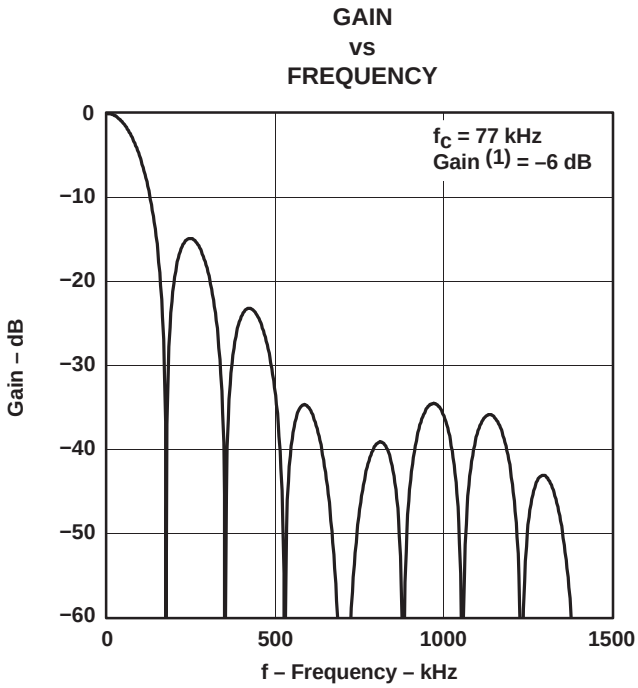


Figure 43. DSD Filter-2, High BW

(1) This gain is in comparison to PCM 0 dB, when the DSD input signal efficiency is 50%.

All specifications at DBCK = 2.8224 MHz (44.1 kHz × 64 f_S), and 50% modulation DSD data input, unless otherwise noted.

ANALOG FIR FILTER PERFORMANCE IN DSD MODE (CONTINUED)

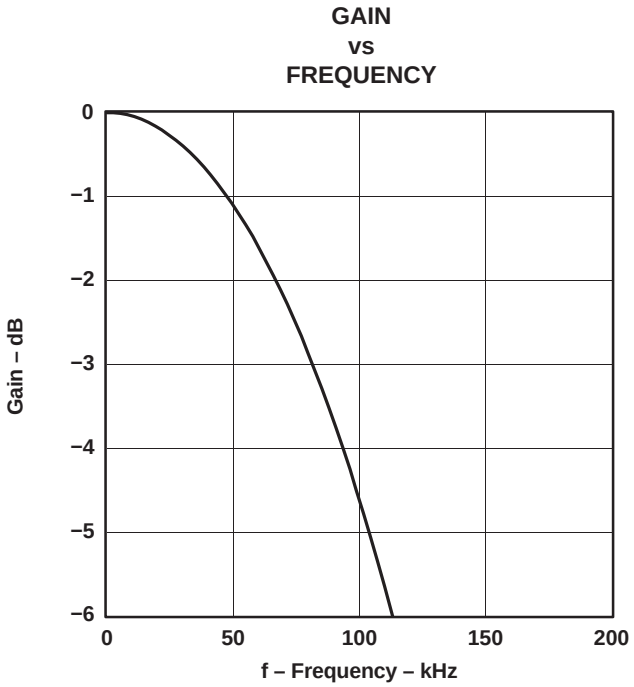


Figure 44. DSD Filter-3, Low BW

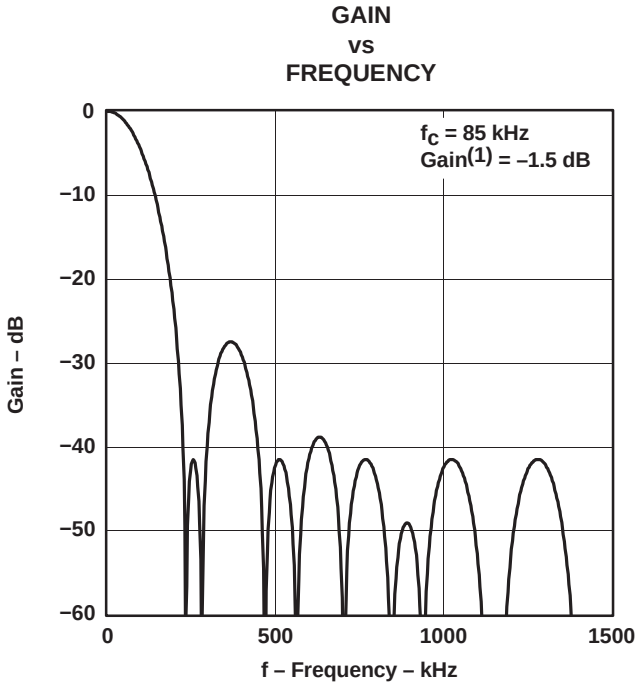


Figure 45. DSD Filter-3, High BW

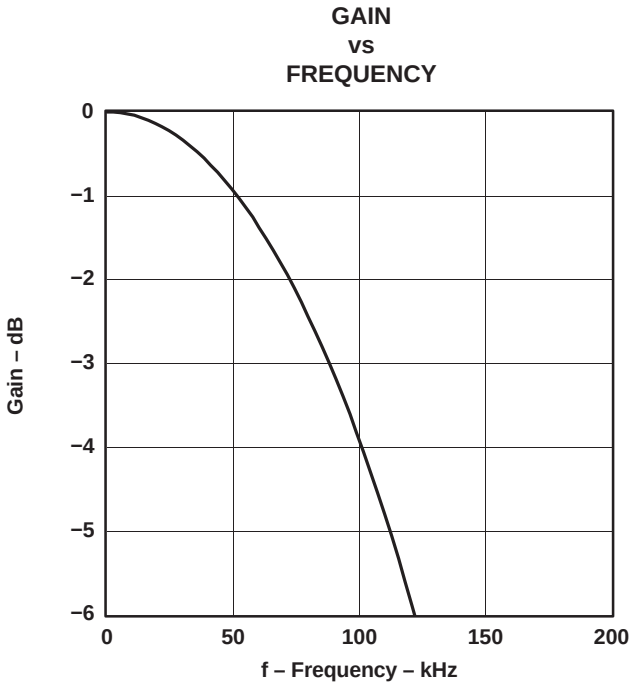


Figure 46. DSD Filter-4, Low BW

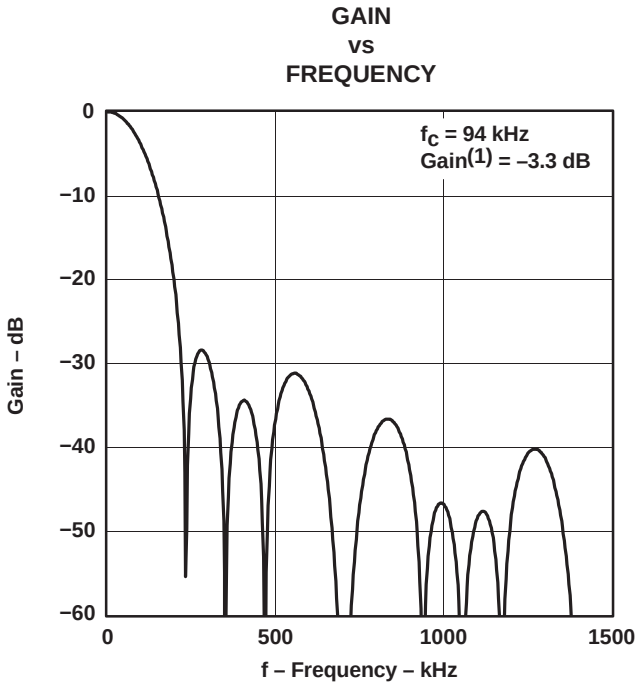


Figure 47. DSD Filter-4, High BW

(1) This gain is in comparison to PCM 0 dB, when the DSD input signal efficiency is 50%.

All specifications at DBCK = 2.8224 MHz (44.1 kHz × 64 f_S), and 50% modulation DSD data input, unless otherwise noted.

DSD MODE CONFIGURATION AND FUNCTION CONTROLS

Configuration for the DSD Interface Mode

DSD = 1 (Register 20, B5)

	B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1	B0
Register 16	R/$\overline{W}$	0	0	1	0	0	0	0	–	–	–	–	–	–	–	–
Register 17	R/$\overline{W}$	0	0	1	0	0	0	1	–	–	–	–	–	–	–	–
Register 18	R/$\overline{W}$	0	0	1	0	0	1	0	–	–	–	–	DMF1	DMF0	–	–
Register 19	R/$\overline{W}$	0	0	1	0	0	1	1	REV	–	–	OPE	–	–	–	–
Register 20	R/$\overline{W}$	0	0	1	0	1	0	0	–	SRST	1	–	MONO	CHSL	OS1	OS0
Register 21	R	0	0	1	0	1	0	1	–	–	–	–	–	DZ1	DZ0	–
Register 22	R	0	0	1	0	1	1	0	–	–	–	–	–	–	ZFGR	ZFGL

NOTE: –: Function is disabled. No operation even if data bit is set

DMF[1:0]: Analog FIR Performance Selection

Default value: 00

DMF[1:0]	Analog FIR Performance Select
00	FIR-1 (default)
01	FIR-2
10	FIR-3
11	FIR-4

Plots for the four analog FIR filter responses are shown in the *ANALOG FIR FILTER PERFORMANCE IN DSD MODE* section of this data sheet.

OS[1:0]: Analog-FIR Operation Speed Selection

Default value: 00

OS[1:0]	Operation Speed Select
00	f_{DBCK} (default)
01	$f_{DBCK}/2$
10	Reserved
11	$f_{DBCK}/4$

The OS bits in the DSD mode select the operating rate of the analog FIR. The OS bits must be set before setting the DSD bit to 1.

THEORY OF OPERATION

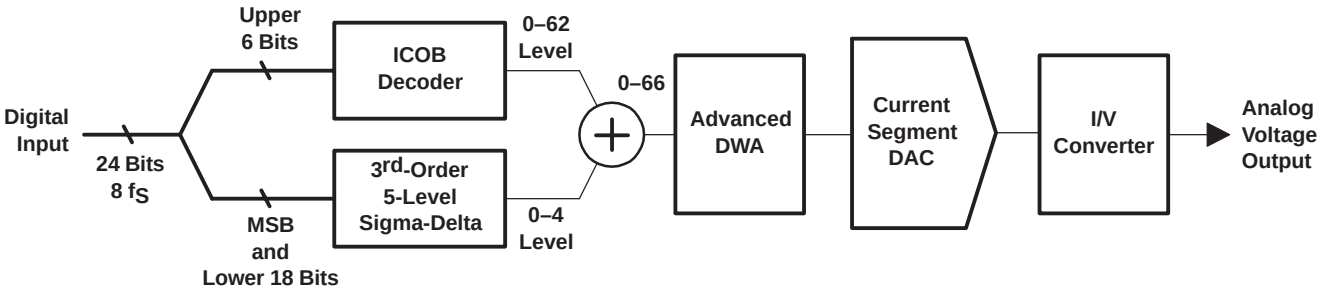


Figure 48. Advanced Segment DAC With I/V Converter

The DSD1793 uses TI's advanced segment DAC architecture to achieve excellent dynamic performance and improved tolerance to clock jitter. The DSD1793 provides balanced voltage outputs.

Digital input data via the digital filter is separated into 6 upper bits and 18 lower bits. The 6 upper bits are converted to inverted complementary offset binary (ICOB) code. The lower 18 bits, in association with the MSB, are processed by a five-level third-order delta-sigma modulator operated at 64 f_S by default. The 1 level of the modulator is equivalent to the 1 LSB of the ICOB code converter. The data groups processed in the ICOB converter and third-order delta-sigma modulator are summed together to an up to 66-level digital code, and then processed by data-weighted averaging (DWA) to reduce the noise produced by element mismatch. The data of up to 66 levels from the DWA is converted to an analog output in the differential-current segment section.

This architecture has overcome the various drawbacks of conventional multibit processing and also achieves excellent dynamic performance.

CONSIDERATIONS FOR APPLICATION CIRCUITS

PCB Layout Guidelines

A typical PCB floor plan for the DSD1793 is shown in Figure 49. A ground plane is recommended, with the analog and digital sections being isolated from one another using a split or cut in the circuit board. The DSD1793 must be oriented with the digital I/O pins facing the ground plane split/cut to allow for short, direct connections to the digital audio interface and control signals originating from the digital section of the board. Separate power supplies are recommended for the digital and analog sections of the board. This prevents the switching noise present on the digital supply from contaminating the analog power supply and degrading the dynamic performance of the D/A converters. In cases where a common 5-V supply would be used for the analog and digital sections, an inductance (RF choke, ferrite bead) must be placed between the analog and digital 5-V supply connections to avoid coupling of the digital switching noise into the analog circuitry. Figure 50 shows the recommended approach for single-supply applications.

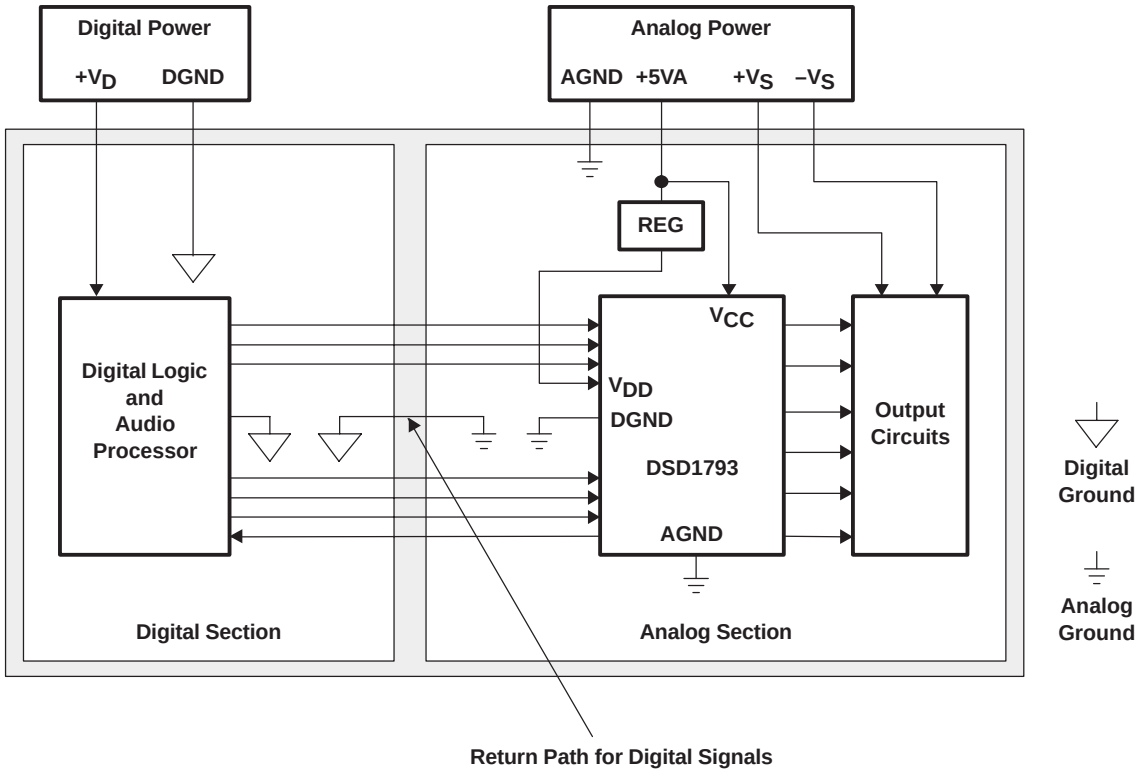


Figure 49. Recommended PCB Layout

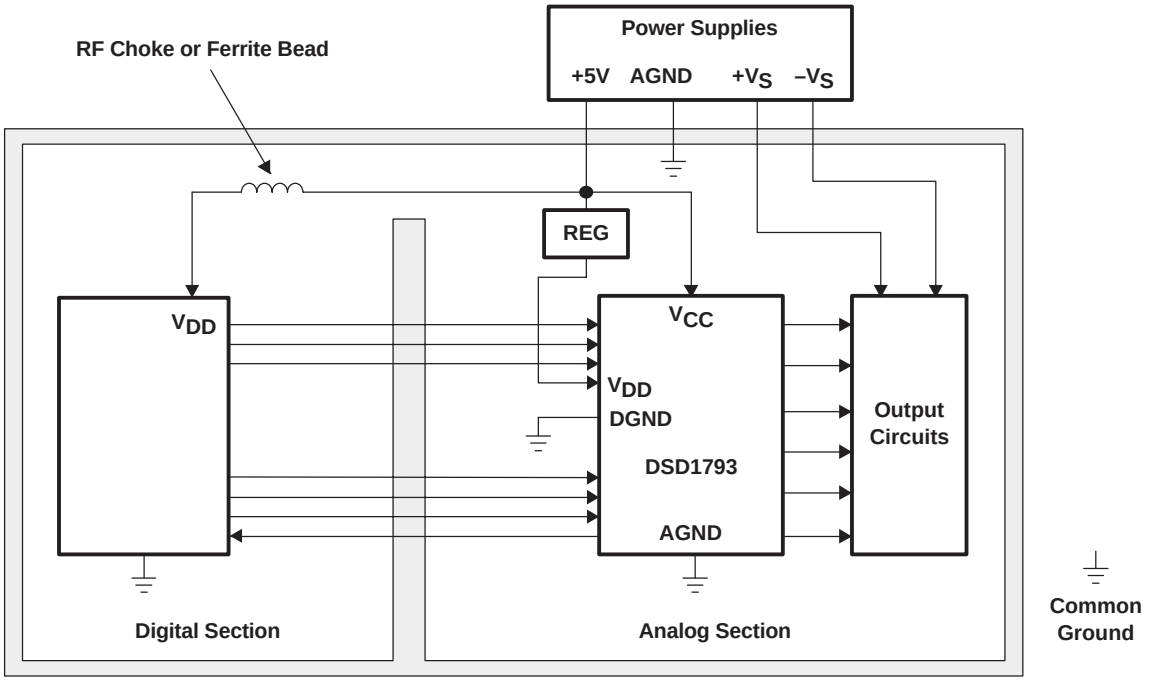


Figure 50. Single-Supply PCB Layout

Bypass and Decoupling Capacitor Requirements

Various sized decoupling capacitors can be used, with no special tolerances being required. All capacitors must be located as close as possible to the appropriate pins of the DSD1793 to reduce noise pickup from surrounding circuitry. Aluminum electrolytic capacitors that are designed for hi-fi audio applications are recommended for larger values, while metal film or monolithic ceramic capacitors are used for smaller values.

Post-LPF Design

By proper choice of the operational amplifier and resistors used in the post-LPF circuit, excellent performance of the DSD1793 should be achieved. To obtain 0.001% THD+N and 113 dB signal-to-noise-ratio audio performance, the THD+N and input noise performance of the operational amplifier should be considered. This is because the input noise of the operational amplifier contributes directly to the output noise level of the application. The V_{OUT} pin of the DSD1793 and the input resistor of the post-LPF circuit must be connected as closely as possible.

Out-of-band noise level and attenuated sampling spectrum level are much lower than for typical delta-sigma type DACs due to the combination of a high-performance digital filter and advanced segment DAC architecture. The use of a second-order or third-order post-LPF is recommended for the post-LPF of the DSD1793. The cutoff frequency of the post-LPF depends on the application. For example, there are many sampling-rate operations such as f_S = 44.1 kHz on CDDA, f_S = 96 kHz on DVD-M, f_S = 192 kHz on DVD-A, f_S = 64 f_S on DSD (SACD).

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)
DSD1793DB	ACTIVE	SSOP	DB	28	47	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
DSD1793DBG4	ACTIVE	SSOP	DB	28	47	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
DSD1793DBR	ACTIVE	SSOP	DB	28	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
DSD1793DBRG4	ACTIVE	SSOP	DB	28	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
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Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

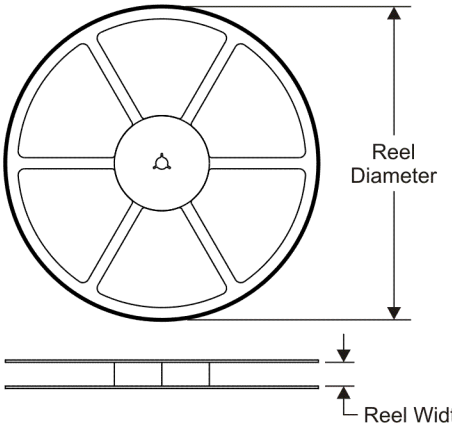
(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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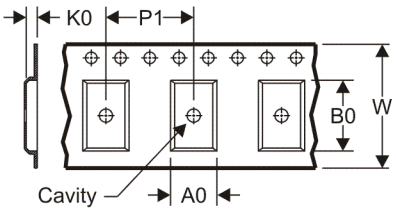
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REEL DIMENSIONS

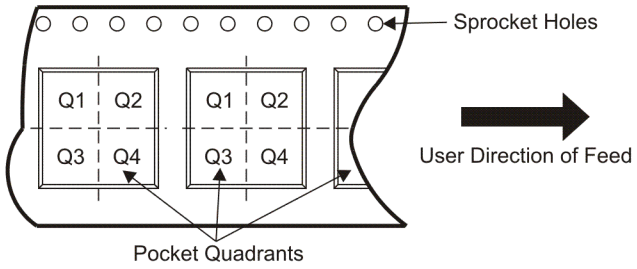


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

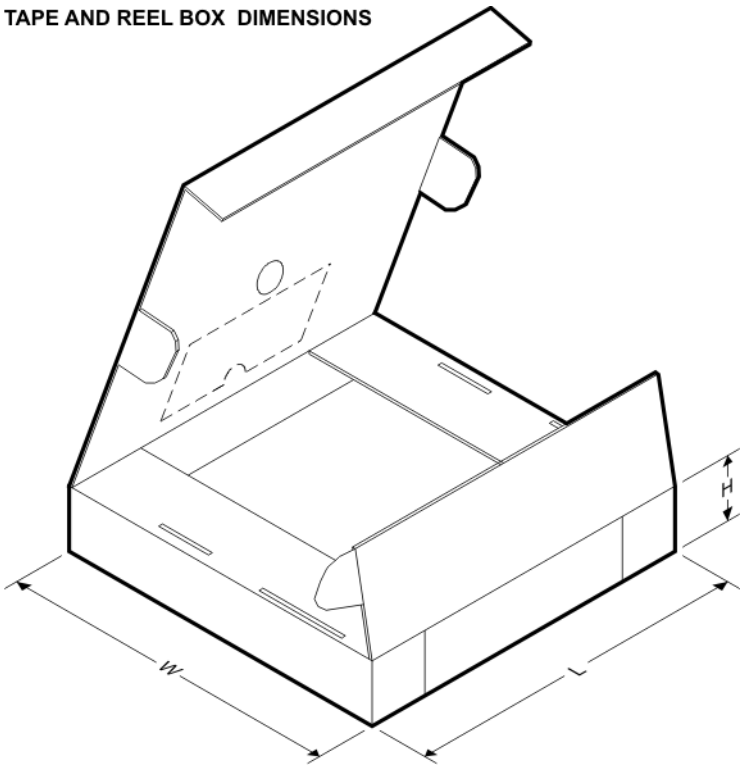
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
DSD1793DBR	SSOP	DB	28	2000	330.0	17.4	8.5	10.8	2.4	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS



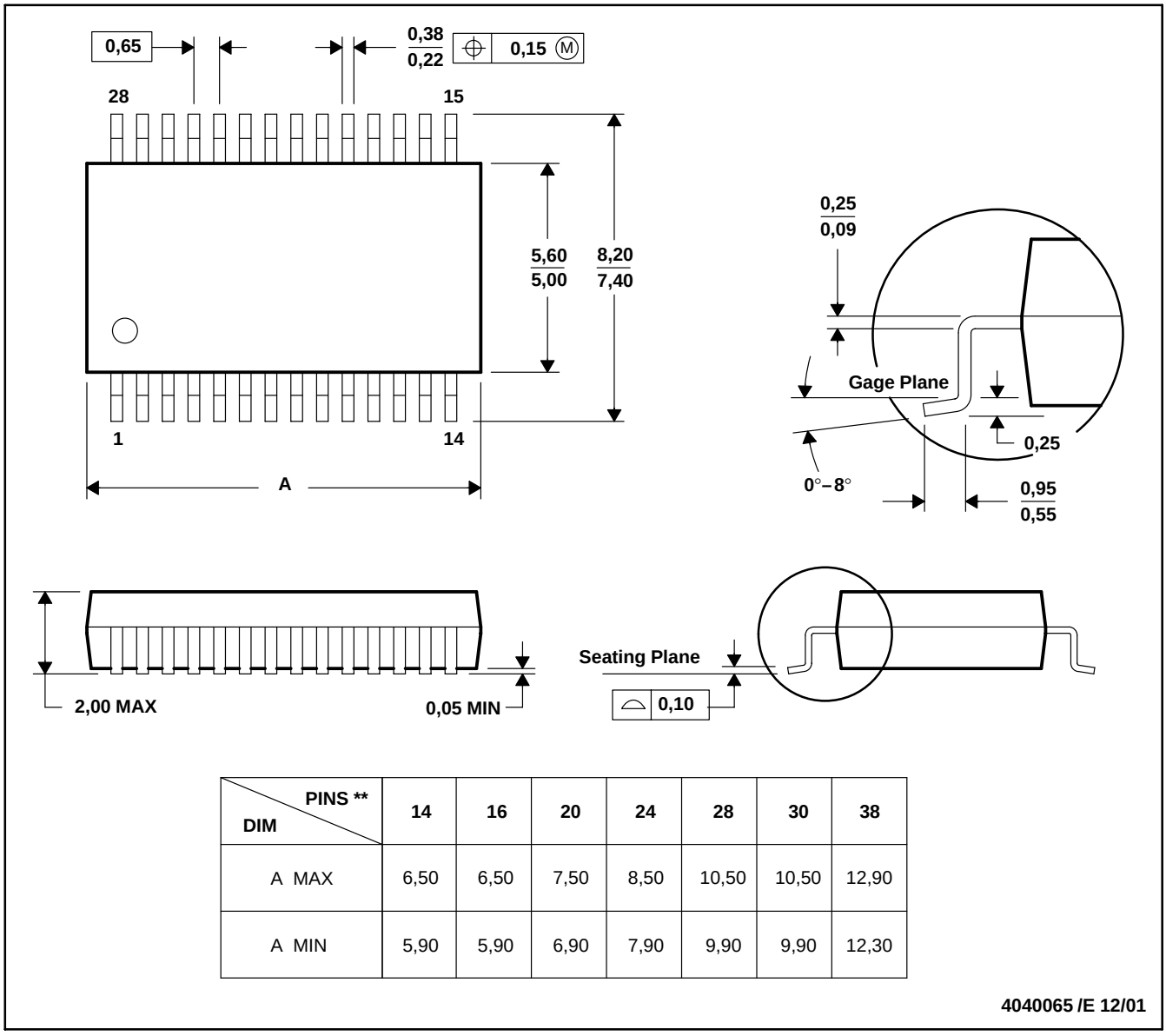
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
DSD1793DBR	SSOP	DB	28	2000	336.6	336.6	28.6

MSSO002E – JANUARY 1995 – REVISED DECEMBER 2001

DB (R-PDSO-G)** **PLASTIC SMALL-OUTLINE**

28 PINS SHOWN



DIM \ PINS **	14	16	20	24	28	30	38
A MAX	6,50	6,50	7,50	8,50	10,50	10,50	12,90
A MIN	5,90	5,90	6,90	7,90	9,90	9,90	12,30

4040065 /E 12/01

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
D. Falls within JEDEC MO-150

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